

# Hot Swap Controller with Multifunction Current Control

## FEATURES

- Allows Safe Board Insertion and Removal from a Live Backplane
- Controls Supply Voltages from 2.5V to 16.5V
- Programmable Soft-Start with Inrush Current Limiting, No External Gate Capacitor Required
- Faster Turn-Off Time Because No External Gate Capacitor is Required
- Dual Level Overcurrent Fault Protection
- Programmable Response Time for Overcurrent Protection (MS)
- Programmable Overvoltage Protection (MS)
- Automatic Retry or Latched Mode Operation (MS)
- High Side Drive for an External N-Channel FET
- User-Programmable Supply Voltage Power-Up Rate
- FB Pin Monitors  $V_{OUT}$  and Signals  $\overline{RESET}$
- Glitch Filter Protects Against Spurious  $\overline{RESET}$  Signal

## APPLICATIONS

- Electronic Circuit Breaker
- Hot Board Insertion and Removal (Either On Backplane or On Removable Card)
- Industrial High Side Switch/Circuit Breaker

## DESCRIPTION

The LTC<sup>®</sup>4211 is a Hot Swap<sup>™</sup> controller that allows a board to be safely inserted and removed from a live backplane. An internal high side switch driver controls the gate of an external N-channel MOSFET for supply voltages ranging from 2.5V to 16.5V. The LTC4211 provides soft-start and inrush current limiting during the start-up period which has a programmable duration.

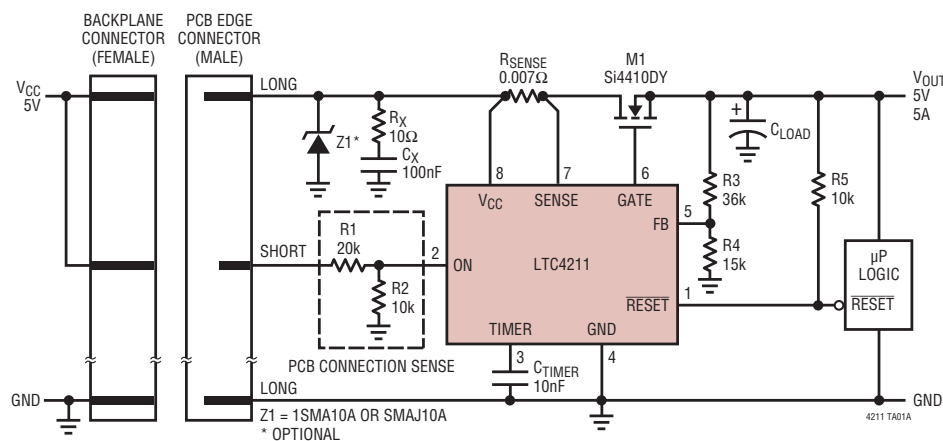
Two on-chip current limit comparators provide dual level overcurrent circuit breaker protection. The slow comparator trips at  $V_{CC} - 50\text{mV}$  and activates in  $20\mu\text{s}$  (or is programmed by an external filter capacitor, MS only). The fast comparator trips at  $V_{CC} - 150\text{mV}$  and typically responds in  $300\text{ns}$ .

The FB pin monitors the output supply voltage and signals the  $\overline{RESET}$  output pin. The ON pin signal turns the chip on and off and can also be used for the reset function. The MS package has  $\overline{FAULT}$  and FILTER pins to provide additional functions like fault indication, autoretry or latch-off modes, programmable current limit response time and programmable overvoltage protection using an external Zener diode clamp.

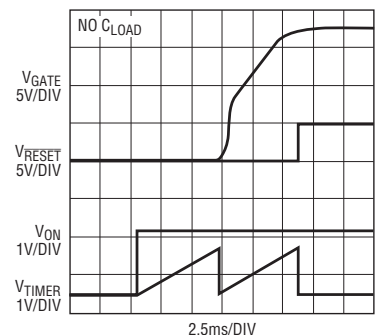
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## TYPICAL APPLICATION

Single Channel 5V Hot Swap Controller



Power-Up Sequence



4211 TA01b

4211fb

# LTC4211

## ABSOLUTE MAXIMUM RATINGS

(Note 1)

Supply Voltage ( $V_{CC}$ ) ..... 17V  
Input Voltage  
FB, ON ..... -0.3V to 17V  
SENSE, FILTER ..... -0.3V to  $V_{CC} + 0.3V$   
TIMER ..... -0.3V to 2V  
Output Voltage  
GATE ..... Internally Limited (Note 3)  
RESET, FAULT ..... -0.3V to 17V

Operating Temperature Range

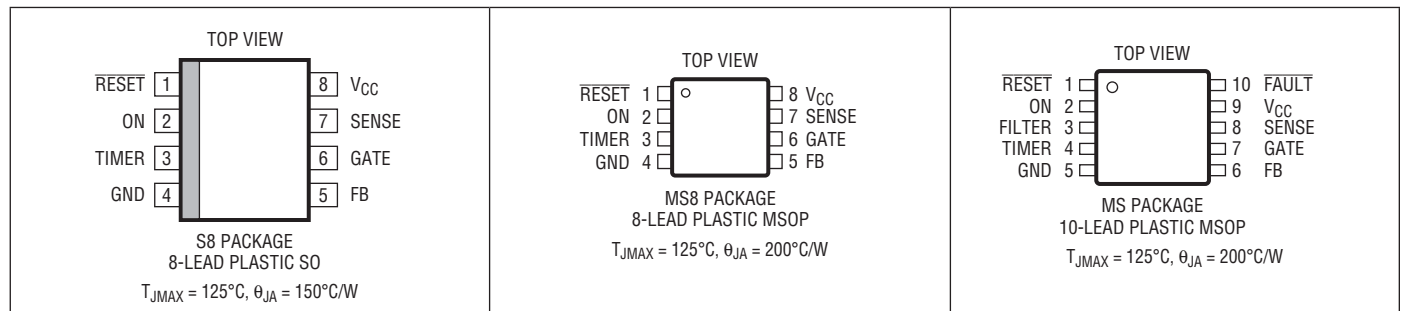
LTC4211C ..... 0°C to 70°C

LTC4211I ..... -40°C to 85°C

Storage Temperature Range ..... -65°C to 150°C

Lead Temperature (Soldering, 10 sec) ..... 300°C

## PIN CONFIGURATION



## ORDER INFORMATION

| LEAD FREE FINISH | TAPE AND REEL     | PART MARKING | PACKAGE DESCRIPTION  | TEMPERATURE RANGE |
|------------------|-------------------|--------------|----------------------|-------------------|
| LTC4211CS8#PBF   | LTC4211CS8#TRPBF  | 4211         | 8-Lead Plastic SO    | 0°C to 70°C       |
| LTC4211IS8#PBF   | LTC4211IS8#TRPBF  | 4211I        | 8-Lead Plastic SO    | -40°C to 85°C     |
| LTC4211CMS8#PBF  | LTC4211CMS8#TRPBF | LTSC         | 8-Lead Plastic MSOP  | 0°C to 70°C       |
| LTC4211IMS8#PBF  | LTC4211IMS8#TRPBF | LTSD         | 8-Lead Plastic MSOP  | -40°C to 85°C     |
| LTC4211CMS#PBF   | LTC4211CMS#TRPBF  | LTSU         | 10-Lead Plastic MSOP | 0°C to 70°C       |
| LTC4211IMS#PBF   | LTC4211IMS#TRPBF  | LTSV         | 10-Lead Plastic MSOP | -40°C to 85°C     |

Consult LTC Marketing for parts specified with wider operating temperature ranges.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

For more information on tape and reel specifications, go to: <http://www.linear.com/tapeandree/>

## ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^{\circ}C$ .  $V_{CC} = 5V$ , unless otherwise noted. (Note 2)

| SYMBOL        | PARAMETER                                | CONDITIONS                        | MIN | TYP  | MAX  | UNITS |
|---------------|------------------------------------------|-----------------------------------|-----|------|------|-------|
| $V_{CC}$      | $V_{CC}$ Supply Voltage Range            | ●                                 | 2.5 |      | 16.5 | V     |
| $I_{CC}$      | $V_{CC}$ Supply Current                  | FB = High, ON = High, TIMER = Low | ●   | 1    | 1.5  | mA    |
| $V_{LKO}$     | Internal $V_{CC}$ Undervoltage Lockout   | $V_{CC}$ Low-to-High Transition   | ●   | 2.13 | 2.3  | V     |
| $V_{LKO HST}$ | $V_{CC}$ Undervoltage Lockout Hysteresis |                                   |     | 120  |      | mV    |
| $I_{INFB}$    | FB Input Current                         | $V_{FB} = V_{CC}$ or GND          |     | ±1   | ±10  | μA    |

4211fb

# ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_{CC} = 5\text{V}$ , unless otherwise noted. (Note 2)

| SYMBOL            | PARAMETER                                   | CONDITIONS                                                            | MIN | TYP       | MAX       | UNITS         |
|-------------------|---------------------------------------------|-----------------------------------------------------------------------|-----|-----------|-----------|---------------|
| $I_{INON}$        | ON Input Current                            | $V_{ON} = V_{CC}$ or GND                                              |     | $\pm 1$   | $\pm 10$  | $\mu\text{A}$ |
| $I_{LEAK}$        | RESET, FAULT Leakage Current                | $V_{RESET} = V_{FAULT} = 15\text{V}$ , Pull-Down Device Off           | ●   | $\pm 0.1$ | $\pm 2.5$ | $\mu\text{A}$ |
| $I_{INSENSE}$     | SENSE Input Current                         | $V_{SENSE} = V_{CC}$ or GND                                           |     | $\pm 1$   | $\pm 10$  | $\mu\text{A}$ |
| $V_{CB(FAST)}$    | SENSE Trip Voltage ( $V_{CC} - V_{SENSE}$ ) | Fast Comparator Trips                                                 | ●   | 130       | 150       | mV            |
| $V_{CB(SLOW)}$    | SENSE Trip Voltage ( $V_{CC} - V_{SENSE}$ ) | Slow Comparator Trips                                                 | ●   | 40        | 50        | mV            |
| $I_{GATEUP}$      | GATE Pull-Up Current                        | Charge Pump On, $V_{GATE} \leq 0.2\text{V}$                           | ●   | -12.5     | -10       | $\mu\text{A}$ |
| $I_{GATEDOWN}$    | Normal GATE Pull-Down Current               | ON Low                                                                | ●   | 130       | 200       | $\mu\text{A}$ |
|                   | Fast GATE Pull-Down Current                 | FAULT Latched and Circuit Breaker Tripped or in UVLO                  |     | 50        |           | mA            |
| $\Delta V_{GATE}$ | External N-Channel Gate Drive               | $V_{GATE} - V_{CC}$ (For $V_{CC} = 2.5\text{V}$ )                     | ●   | 2.5       | 8         | V             |
|                   |                                             | $V_{GATE} - V_{CC}$ (For $V_{CC} = 2.7\text{V}$ )                     | ●   | 4.5       | 8         | V             |
|                   |                                             | $V_{GATE} - V_{CC}$ (For $V_{CC} = 3.3\text{V}$ )                     | ●   | 5.0       | 10        | V             |
|                   |                                             | $V_{GATE} - V_{CC}$ (For $V_{CC} = 5\text{V}$ )                       | ●   | 10        | 16        | V             |
|                   |                                             | $V_{GATE} - V_{CC}$ (For $V_{CC} = 12\text{V}$ )                      | ●   | 10        | 18        | V             |
|                   |                                             | $V_{GATE} - V_{CC}$ (For $V_{CC} = 15\text{V}$ )                      | ●   | 8         | 18        | V             |
| $V_{GATEOV}$      | GATE Overvoltage Lockout Threshold          |                                                                       | ●   | 0.08      | 0.2       | V             |
| $V_{FB}$          | FB Voltage Threshold                        | FB High to Low                                                        | ●   | 1.223     | 1.236     | V             |
| $\Delta V_{FB}$   | FB Threshold Line Regulation                | $2.5\text{V} \leq V_{CC} \leq 16.5\text{V}$                           | ●   | 0.5       | 5         | mV            |
| $V_{FBHST}$       | FB Voltage Threshold Hysteresis             |                                                                       |     | 3         |           | mV            |
| $V_{ONHI}$        | ON Threshold High                           |                                                                       | ●   | 1.23      | 1.316     | V             |
| $V_{ONLO}$        | ON Threshold Low                            |                                                                       | ●   | 1.20      | 1.236     | V             |
| $V_{ONHST}$       | ON Hysteresis                               |                                                                       |     | 80        |           | mV            |
| $I_{FILTER}$      | FILTER Current                              | During Slow Fault Condition                                           | ●   | -2.5      | -2        | $\mu\text{A}$ |
|                   |                                             | During Normal and Reset Conditions                                    | ●   | 7         | 10        | $\mu\text{A}$ |
| $V_{FILTER}$      | FILTER Threshold                            | Latched Off Threshold, FILTER Low to High                             | ●   | 1.20      | 1.236     | V             |
| $V_{FILTERHST}$   | FILTER Threshold Hysteresis                 |                                                                       |     | 80        |           | mV            |
| $I_{TMR}$         | TIMER Current                               | Timer On, $V_{TIMER} = 1\text{V}$                                     | ●   | -2.5      | -2        | $\mu\text{A}$ |
|                   |                                             | Timer Off, $TIMER = 1.5\text{V}$                                      |     | 3         |           | mA            |
| $V_{TMR}$         | TIMER Threshold                             | TIMER Low to High                                                     | ●   | 1.20      | 1.236     | V             |
|                   |                                             | TIMER High to Low                                                     | ●   | 0.15      | 0.200     | V             |
| $V_{FAULT}$       | FAULT Threshold                             | Latched Off Threshold, FAULT High to Low                              | ●   | 1.20      | 1.236     | V             |
| $V_{FAULTHST}$    | FAULT Threshold Hysteresis                  |                                                                       |     | 50        |           | mV            |
| $V_{OLFAULT}$     | Output Low Voltage                          | $I_{FAULT} = 1.6\text{mA}$                                            | ●   | 0.14      | 0.4       | V             |
| $V_{OLRESET}$     | Output Low Voltage                          | $I_{RESET} = 1.6\text{mA}$                                            | ●   | 0.14      | 0.4       | V             |
| $t_{FAULTFC}$     | FAST COMP Trip to GATE Discharging          | $V_{CB} = 0\text{mV}$ to 200mV Step                                   | ●   | 300       | 700       | ns            |
| $t_{FAULTSC}$     | SLOW COMP Trip to GATE Discharging          | $V_{CB} = 0\text{mV}$ to 100mV Step, 8-Pin Version or FILTER Floating | ●   | 10        | 20        | $\mu\text{s}$ |
|                   |                                             | $V_{CB} = 0\text{mV}$ to 100mV Step, 10nF at FILTER Pin to GND        | ●   | 4         | 6         | ms            |
| $t_{EXTFAULT}$    | FAULT Low to GATE Discharging               | $V_{FAULT} = 5\text{V}$ to 0V                                         | ●   | 1         | 3         | $\mu\text{s}$ |
| $t_{FILTER}$      | FILTER High to FAULT Latched                | $V_{FILTER} = 0\text{V}$ to 5V                                        | ●   | 2         | 4.5       | $\mu\text{s}$ |

## ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_{CC} = 5\text{V}$ , unless otherwise noted. (Note 2)

| SYMBOL             | PARAMETER                        | CONDITIONS           | MIN | TYP | MAX | UNITS         |
|--------------------|----------------------------------|----------------------|-----|-----|-----|---------------|
| $t_{\text{RESET}}$ | Circuit Breaker Reset Delay Time | ON Low to FAULT High | ●   | 150 | 250 | $\mu\text{s}$ |
| $t_{\text{OFF}}$   | Turn-Off Time                    | ON Low to GATE Off   |     | 8   |     | $\mu\text{s}$ |

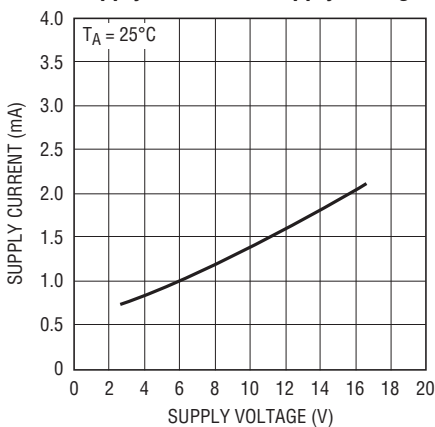
**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

**Note 2:** All current into device pins are positive; all current out of device pins are negative; all voltages are referenced to ground unless otherwise specified.

**Note 3:** An internal Zener at the GATE pin clamps the charge pump voltage to a typical maximum operating voltage of 26V. External voltage applied to the GATE pin beyond the internal Zener voltage may damage the part. If a lower GATE pin voltage is desired, use an external Zener diode. The GATE capacitance must be  $< 0.15\mu\text{F}$  at maximum  $V_{CC}$ .

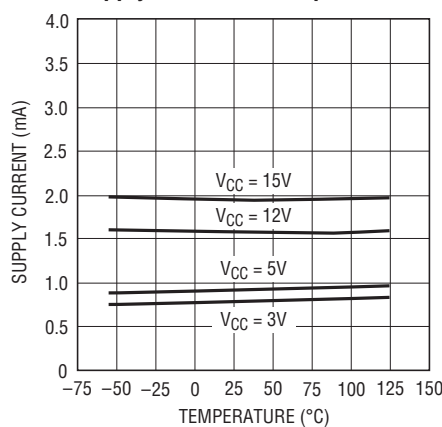
## TYPICAL PERFORMANCE CHARACTERISTICS

Supply Current vs Supply Voltage



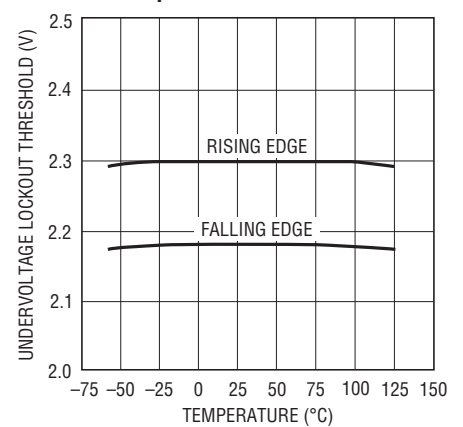
4211 G01

Supply Current vs Temperature



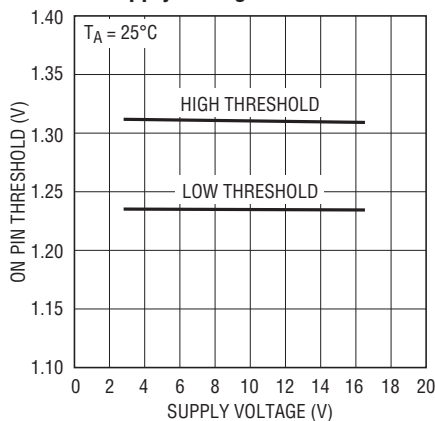
4211 G02

Undervoltage Lockout Threshold vs Temperature



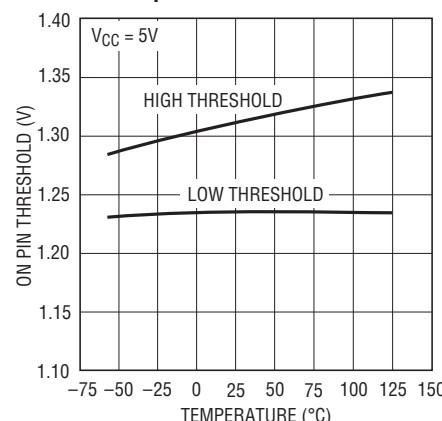
4211 G03

ON Pin Threshold vs Supply Voltage



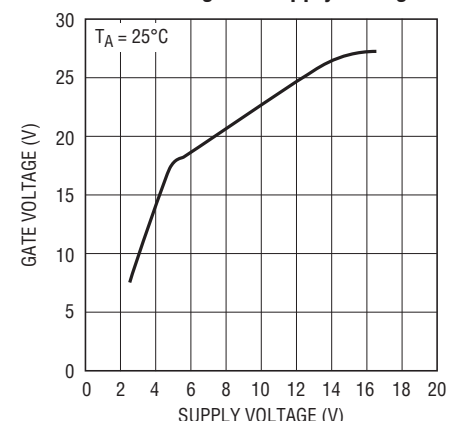
4211 G04

ON Pin Threshold vs Temperature



4211 G05

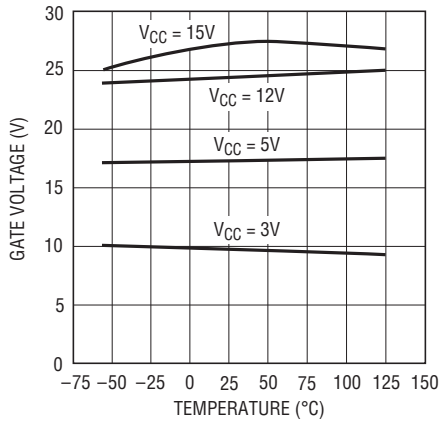
GATE Voltage vs Supply Voltage



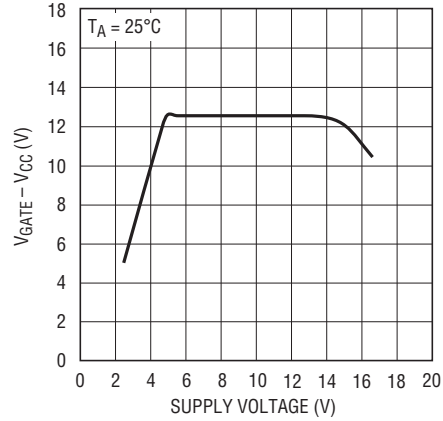
4211 G06

## TYPICAL PERFORMANCE CHARACTERISTICS

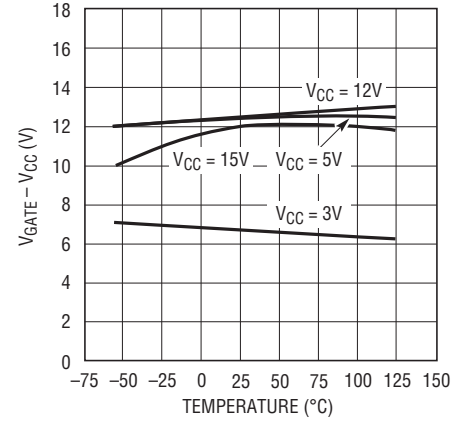
GATE Voltage vs Temperature



4211 G07

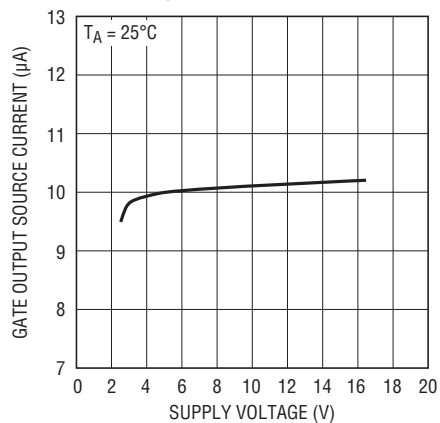
 $V_{GATE} - V_{CC}$  vs Supply Voltage

4211 G08

 $V_{GATE} - V_{CC}$  vs Temperature

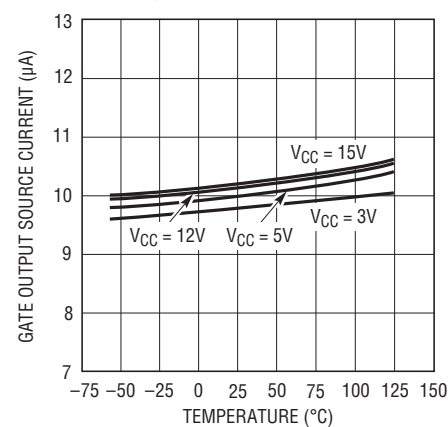
4211 G09

GATE Output Source Current vs Supply Voltage



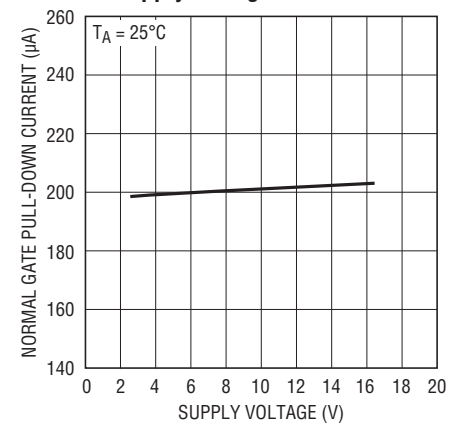
4211 G10

GATE Output Source Current vs Temperature



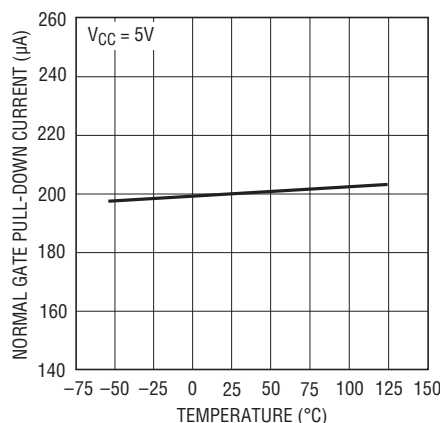
4211 G11

Normal GATE Pull-Down Current vs Supply Voltage



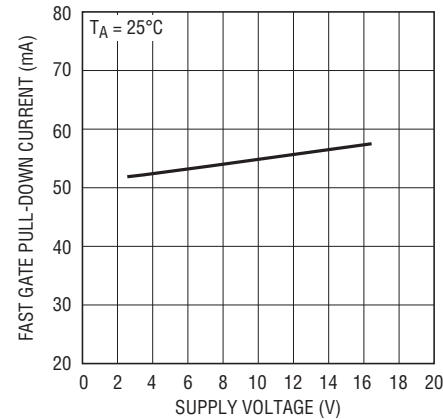
4211 G12

Normal GATE Pull-Down Current vs Temperature



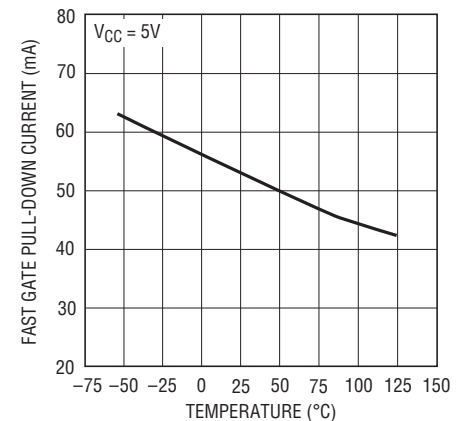
4211 G13

Fast GATE Pull-Down Current vs Supply Voltage



4211 G14

Fast GATE Pull-Down Current vs Temperature

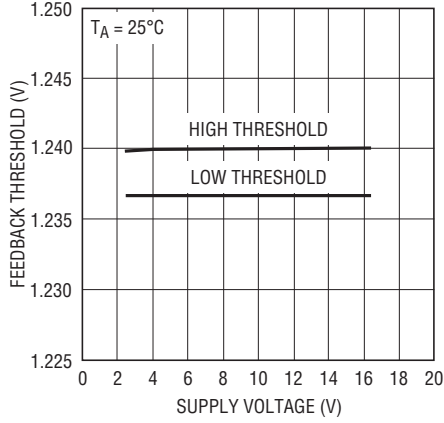


4211 G15

4211fb

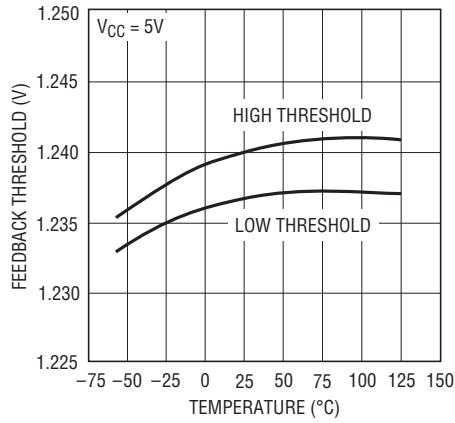
# TYPICAL PERFORMANCE CHARACTERISTICS

**Feedback Threshold vs Supply Voltage**



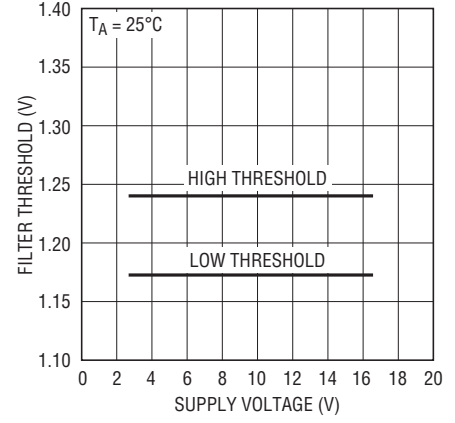
4211 G16

**Feedback Threshold vs Temperature**



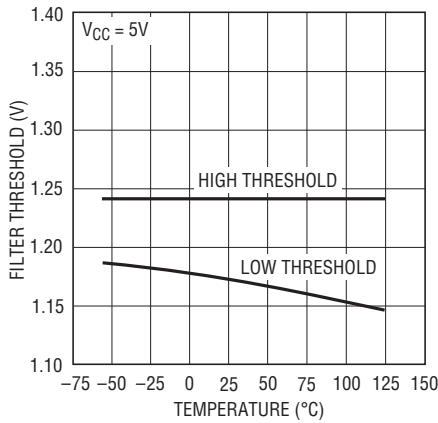
4211 G17

**FILTER Threshold vs Supply Voltage**



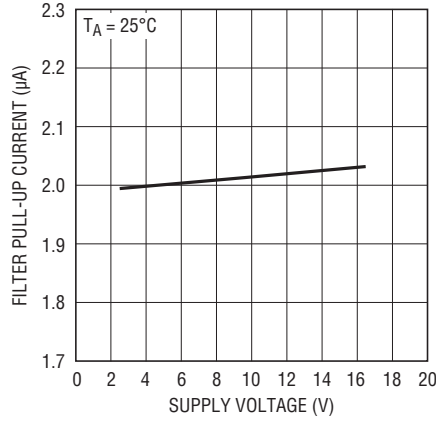
4211 G18

**FILTER Threshold vs Temperature**



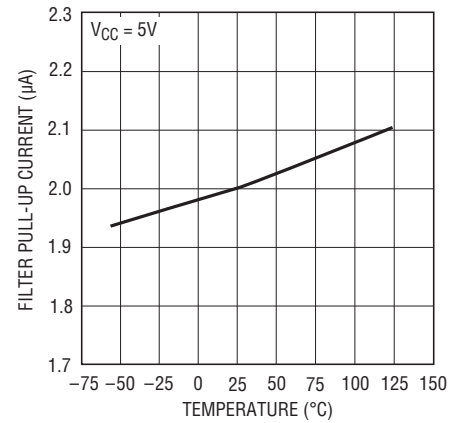
4211 G19

**FILTER Pull-Up Current vs Supply Voltage**



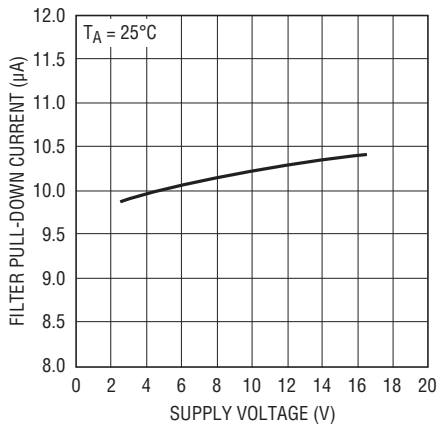
4211 G20

**FILTER Pull-Up Current vs Temperature**



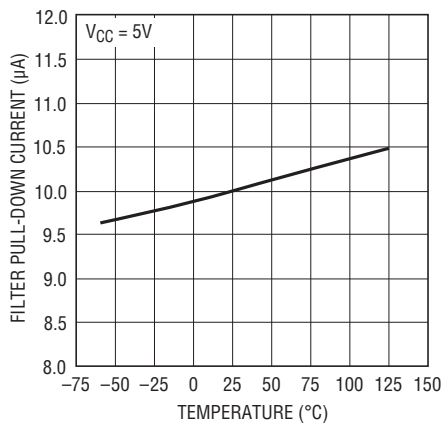
4211 G21

**FILTER Pull-Down Current vs Supply Voltage**



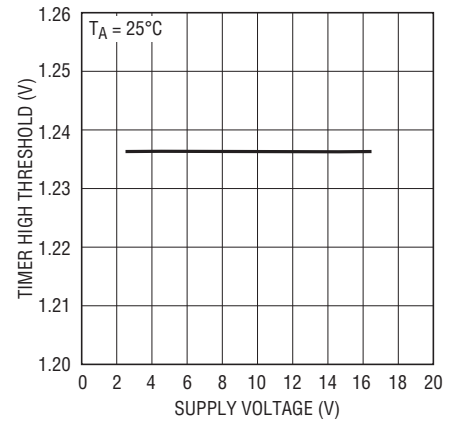
4211 G22

**FILTER Pull-Down Current vs Temperature**



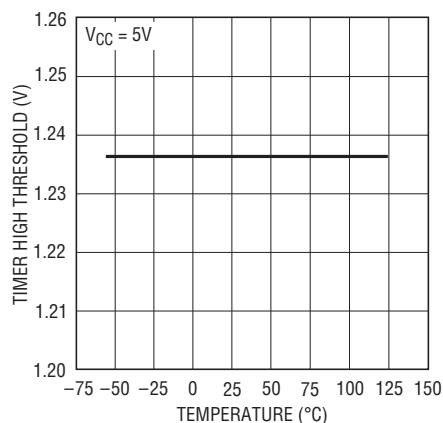
4211 G23

**TIMER High Threshold vs Supply Voltage**

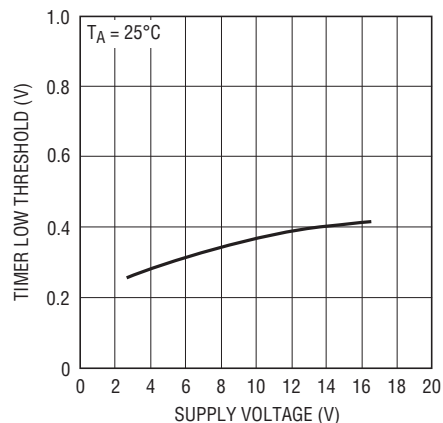


4211 G24

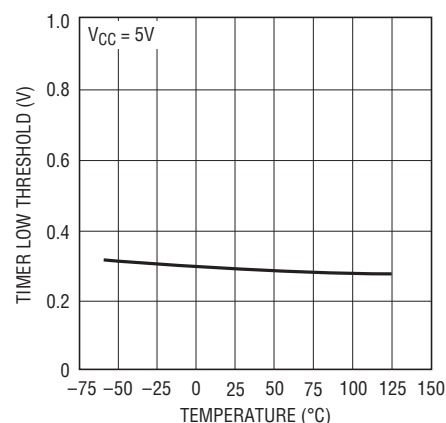
## TYPICAL PERFORMANCE CHARACTERISTICS

TIMER High Threshold  
vs Temperature

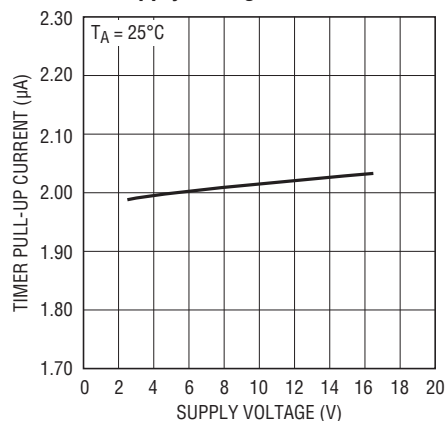
4211 G25

TIMER Low Threshold  
vs Supply Voltage

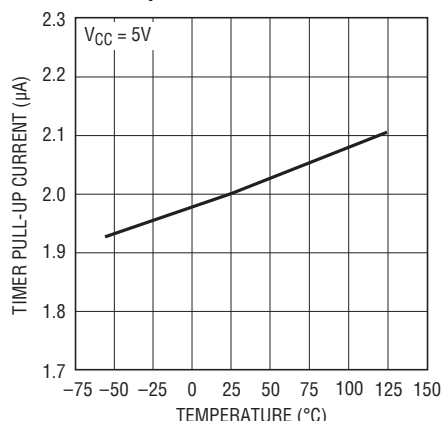
4211 G26

TIMER Low Threshold  
vs Temperature

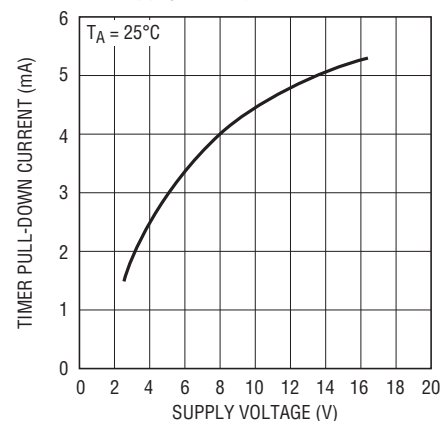
4211 G27

TIMER Pull-Up Current  
vs Supply Voltage

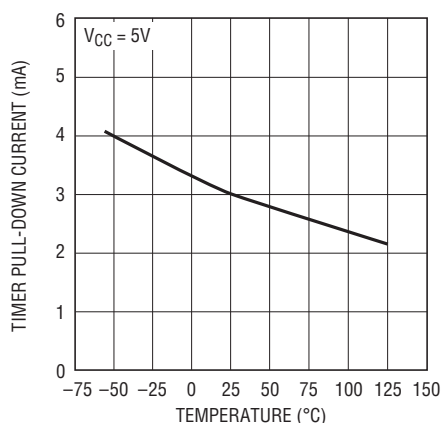
4211 G28

TIMER Pull-Up Current  
vs Temperature

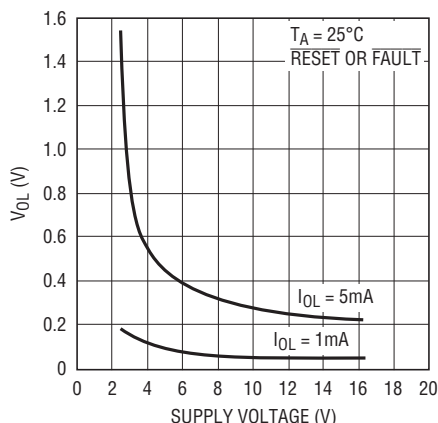
4211 G29

TIMER Pull-Down Current  
vs Supply Voltage

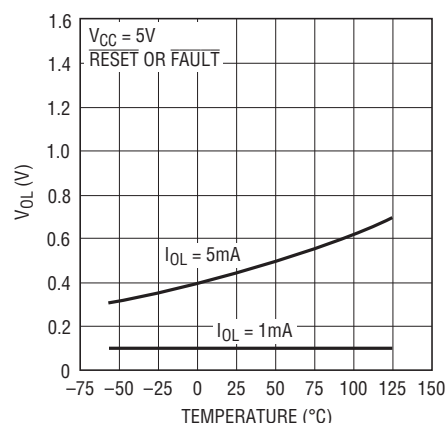
4211 G30

TIMER Pull-Down Current  
vs Temperature

4211 G31

 $V_{OL}$  vs Supply Voltage

4211 G32

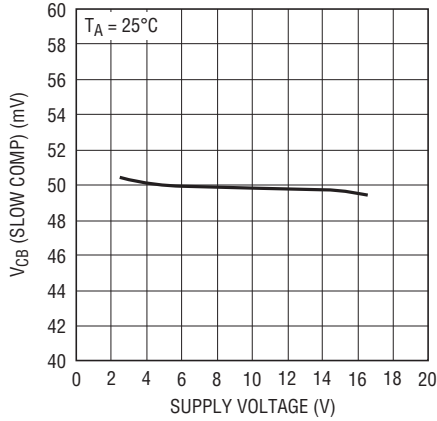
 $V_{OL}$  vs Temperature

4211 G33

4211fb

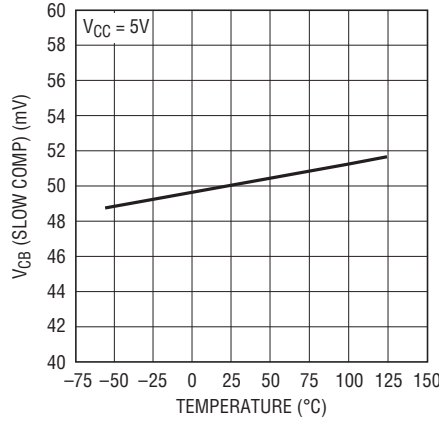
# TYPICAL PERFORMANCE CHARACTERISTICS

**V<sub>CB</sub> (SLOW COMP)  
vs Supply Voltage**



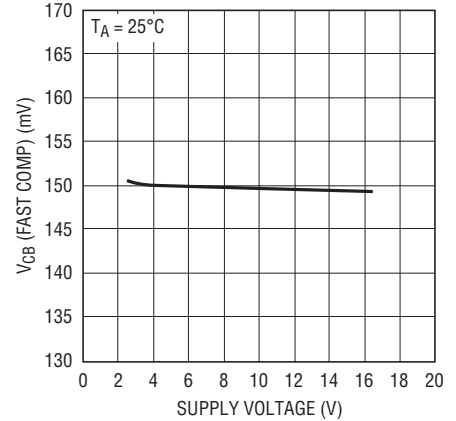
4211 G34

**V<sub>CB</sub> (SLOW COMP)  
vs Temperature**



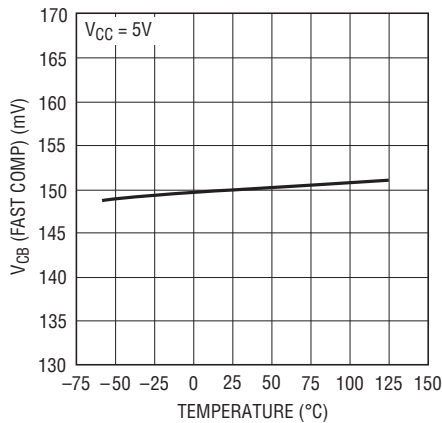
4211 G35

**V<sub>CB</sub> (FAST COMP)  
vs Supply Voltage**



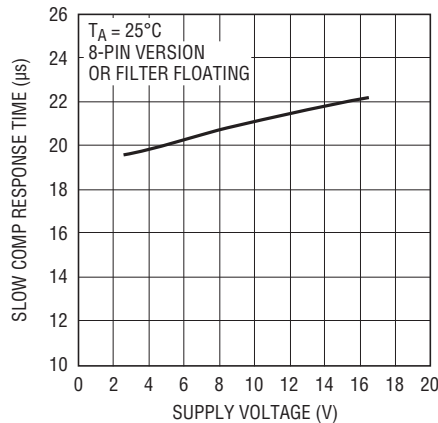
4211 G36

**V<sub>CB</sub> (FAST COMP)  
vs Temperature**



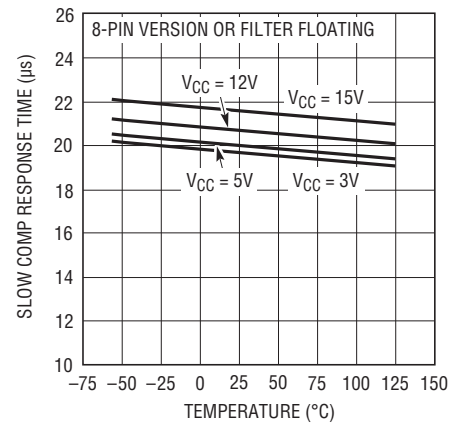
4211 G37

**SLOW COMP Response Time vs  
Supply Voltage**



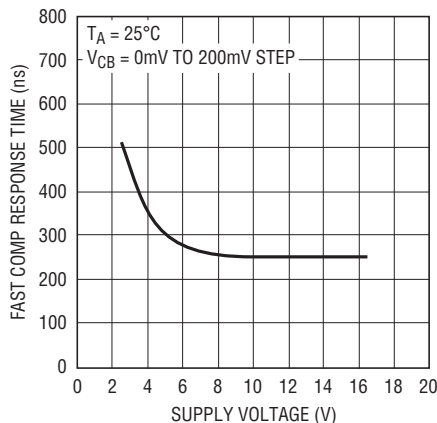
4211 G38

**SLOW COMP Response Time vs  
Temperature**



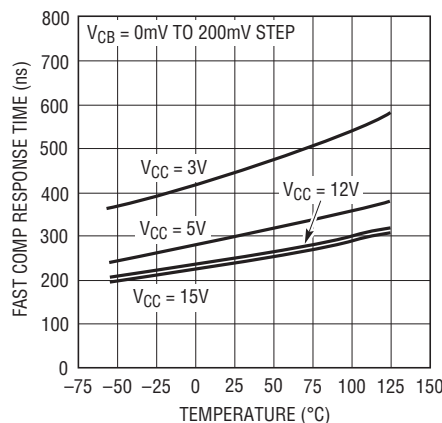
4211 G39

**FAST COMP Response Time vs  
Supply Voltage**



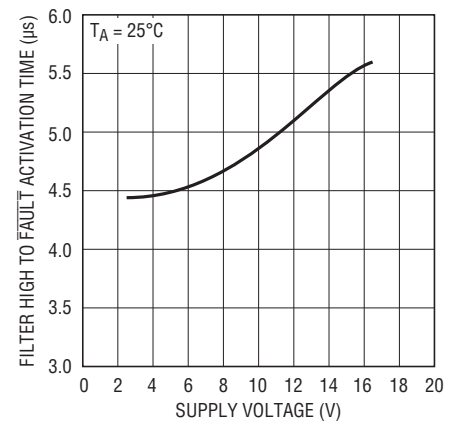
4211 G40

**FAST COMP Response Time vs  
Temperature**



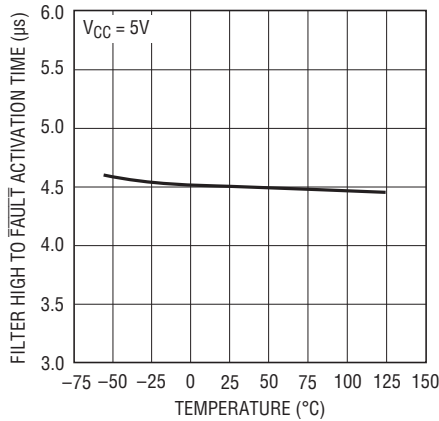
4211 G41

**FILTER High to FAULT Activation  
Time vs Supply Voltage**



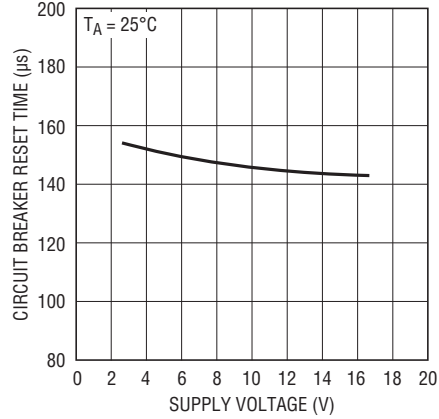
4211 G42

## TYPICAL PERFORMANCE CHARACTERISTICS

FILTER High to  $\overline{\text{FAULT}}$  Activation Time vs Temperature

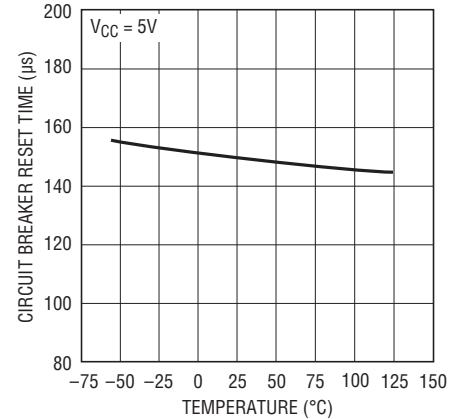
4211 G43

Circuit Breaker RESET Time vs Supply Voltage

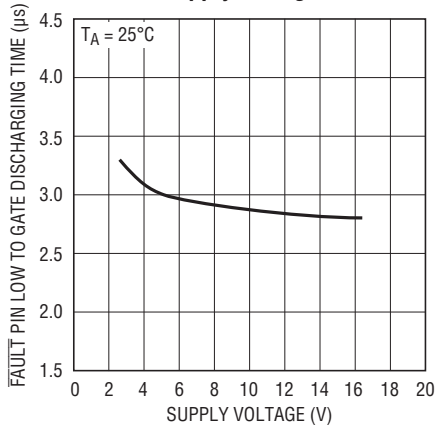


4211 G44

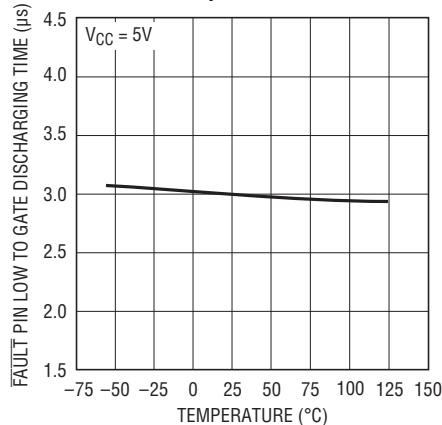
Circuit Breaker RESET Time vs Temperature



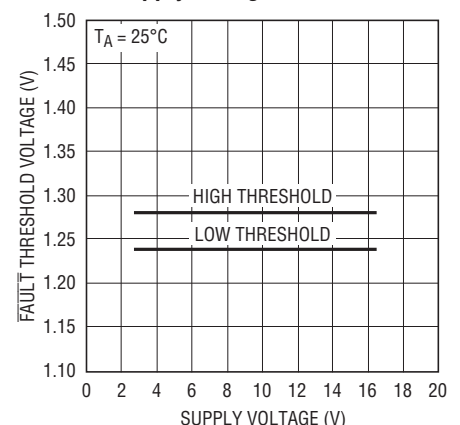
4211 G45

 $\overline{\text{FAULT}}$  Pin Low to GATE Discharging Time vs Supply Voltage

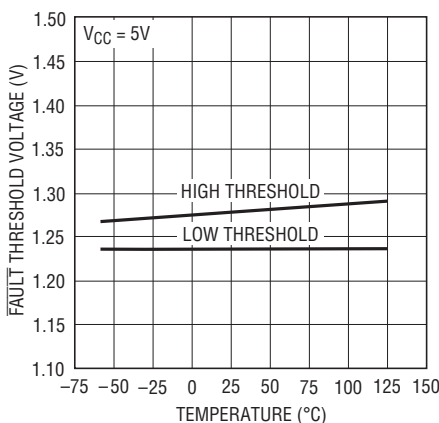
4211 G46

 $\overline{\text{FAULT}}$  Pin Low to GATE Discharging Time vs Temperature

4211 G47

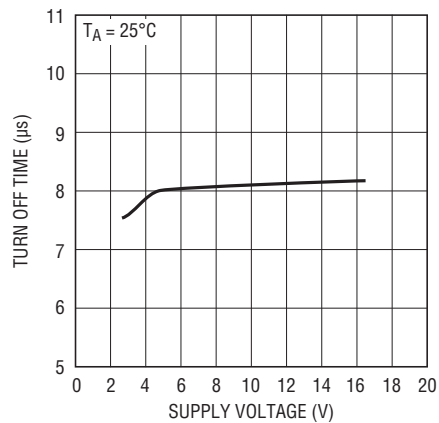
 $\overline{\text{FAULT}}$  Threshold Voltage vs Supply Voltage

4211 G48

 $\overline{\text{FAULT}}$  Threshold Voltage vs Temperature

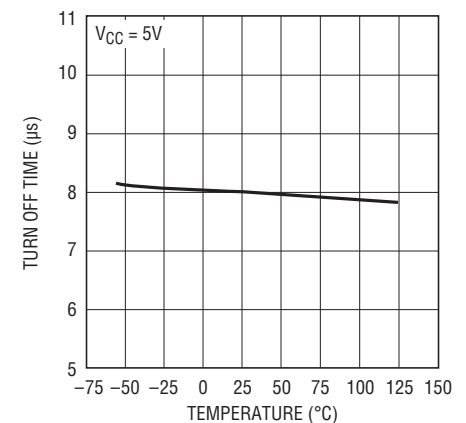
4211 G49

Turn Off Time vs Supply Voltage



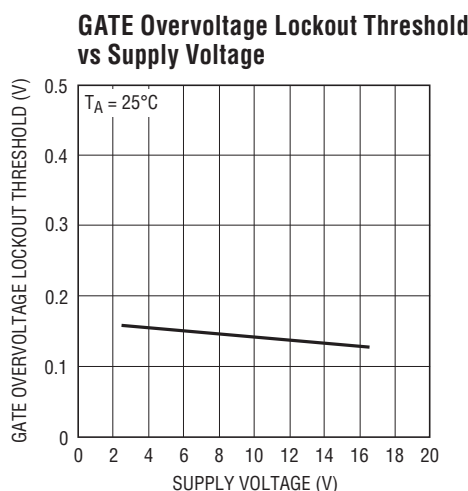
4211 G50

Turn Off Time vs Temperature

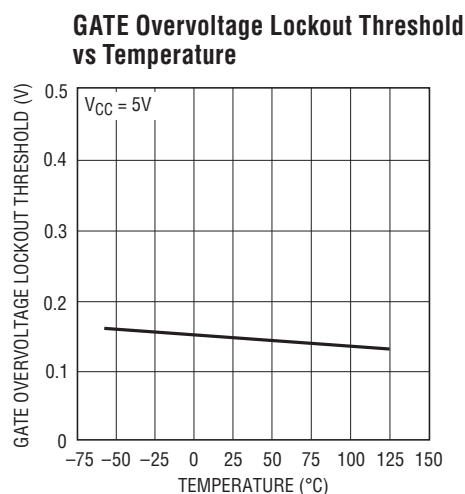


4211 G51

## TYPICAL PERFORMANCE CHARACTERISTICS



4211 G52



4211 G53

## PIN FUNCTIONS (8-Lead Package/10-Lead Package)

**RESET (Pin 1/Pin 1):** An open-drain output that pulls to GND if the voltage at the FB pin (Pin 5/Pin 6) falls below the FB pin threshold (1.236V). During the start-up cycle, the RESET pin goes high impedance at the end of the second timing cycle after the FB pin goes above the FB threshold. This pin requires an external pull-up resistor to  $V_{CC}$ . If an undervoltage lockout condition occurs, the RESET pin pulls low independently of the FB pin to prevent false glitches.

**ON (Pin 2/Pin 2):** An active high signal used to enable or disable LTC4211 operation. COMP1's high-to-low threshold is set at 1.236V and its hysteresis is set at 80mV. If a logic high signal is applied to the ON pin ( $V_{ON} > 1.316\text{V}$ ), the first timing cycle begins if an overvoltage condition does not exist on the GATE pin (Pin 6/Pin 7). If a logic low signal is applied to the ON pin ( $V_{ON} < 1.236\text{V}$ ), the GATE pin is pulled low by an internal 200 $\mu\text{A}$  current sink. The ON pin can also be used to reset the electronic circuit breaker. If the ON pin is cycled low and then high following a circuit breaker trip, the internal circuit breaker is reset, and the LTC4211 begins a new start-up cycle.

**TIMER (Pin 3/Pin 4):** A capacitor connected from this pin to GND sets the LTC4211's system timing. The LTC4211's initial and second start-up timing cycles and its internal "power good" delay time are defined by this capacitor.

**GND (Pin 4/Pin 5):** Device Ground Connection. Connect this pin to the system's analog ground plane.

**FB (Pin 5/Pin 6):** The FB (Feedback) pin is an input to the COMP2 comparator and monitors the output supply voltage through an external resistor divider. If  $V_{FB} < 1.236\text{V}$ , the RESET pin pulls low. An internal glitch filter at COMP2's output helps prevent negative voltage transients from triggering a reset condition. If  $V_{FB} > 1.239\text{V}$ , the RESET pin goes high at the end of the second timing cycle.

**GATE (Pin 6/Pin 7):** The output signal at this pin is the high side gate drive for the external N-channel FET pass transistor.

As shown in the Block Diagram, an internal charge pump supplies a 10 $\mu\text{A}$  gate current and sufficient gate voltage drive to the external FET for supply voltages from 2.5V to 16.5V. The internal charge-pump and zener

## PIN FUNCTIONS (8-Lead Package/10-Lead Package)

clamps at the GATE pin determine the gate drive voltage ( $\Delta V_{\text{GATE}} = V_{\text{GATE}} - V_{\text{CC}}$ ). The charge pump produces a minimum 4.5V of  $\Delta V_{\text{GATE}}$  for supplies in the range of  $2.7\text{V} \leq V_{\text{CC}} < 4.75\text{V}$ . For  $4.75\text{V} \leq V_{\text{CC}} \leq 12\text{V}$  the  $\Delta V_{\text{GATE}}$  is limited by zener clamp Z1 connected between the GATE and  $V_{\text{CC}}$  pins. The  $\Delta V_{\text{GATE}}$  is typically at 12V and with guaranteed minimum value of 10V. For  $V_{\text{CC}} > 12\text{V}$ , the Zener clamp Z2 begins to set the limitation for  $\Delta V_{\text{GATE}}$ . Z2 clamps the gate voltage to ground to 26V typically. The minimum Z2's clamp voltage is 23V. This effectively sets  $\Delta V_{\text{GATE}}$  to 8V minimum at  $V_{\text{CC}} = 15\text{V}$ .

**SENSE (Pin 7/Pin 8):** Circuit Breaker Set Pin. With a sense resistor placed in the power path between  $V_{\text{CC}}$  and SENSE, the LTC4211's electronic circuit breaker trips if the voltage across the sense resistor exceeds the thresholds set internally for the SLOW COMP and the FAST COMP, as shown in the Block Diagram. The threshold for the SLOW COMP is  $V_{\text{CB(SLOW)}} = 50\text{mV}$ , and the electronic circuit breaker trips if the voltage across the sense resistor exceeds 50mV for 20 $\mu\text{s}$ . The SLOW COMP delay is fixed in the S8/MS8 version and adjustable in the MS version of the LTC4211. To adjust the SLOW COMP's delay, please refer to the section on Adjusting SLOW COMP's Response Time.

Under transient conditions where large step current changes can and do occur over shorter periods of time, a second (fast) comparator instead trips the electronic circuit breaker. The threshold for the FAST COMP is set at  $V_{\text{CB(FAST)}} = 150\text{mV}$ , and the circuit breaker trips if the voltage across the sense resistor exceeds 150mV for more than 300ns. The FAST COMP's delay is fixed in the LTC4211 and cannot be adjusted. To disable the electronic circuit breaker, connect the  $V_{\text{CC}}$  and SENSE pins together.

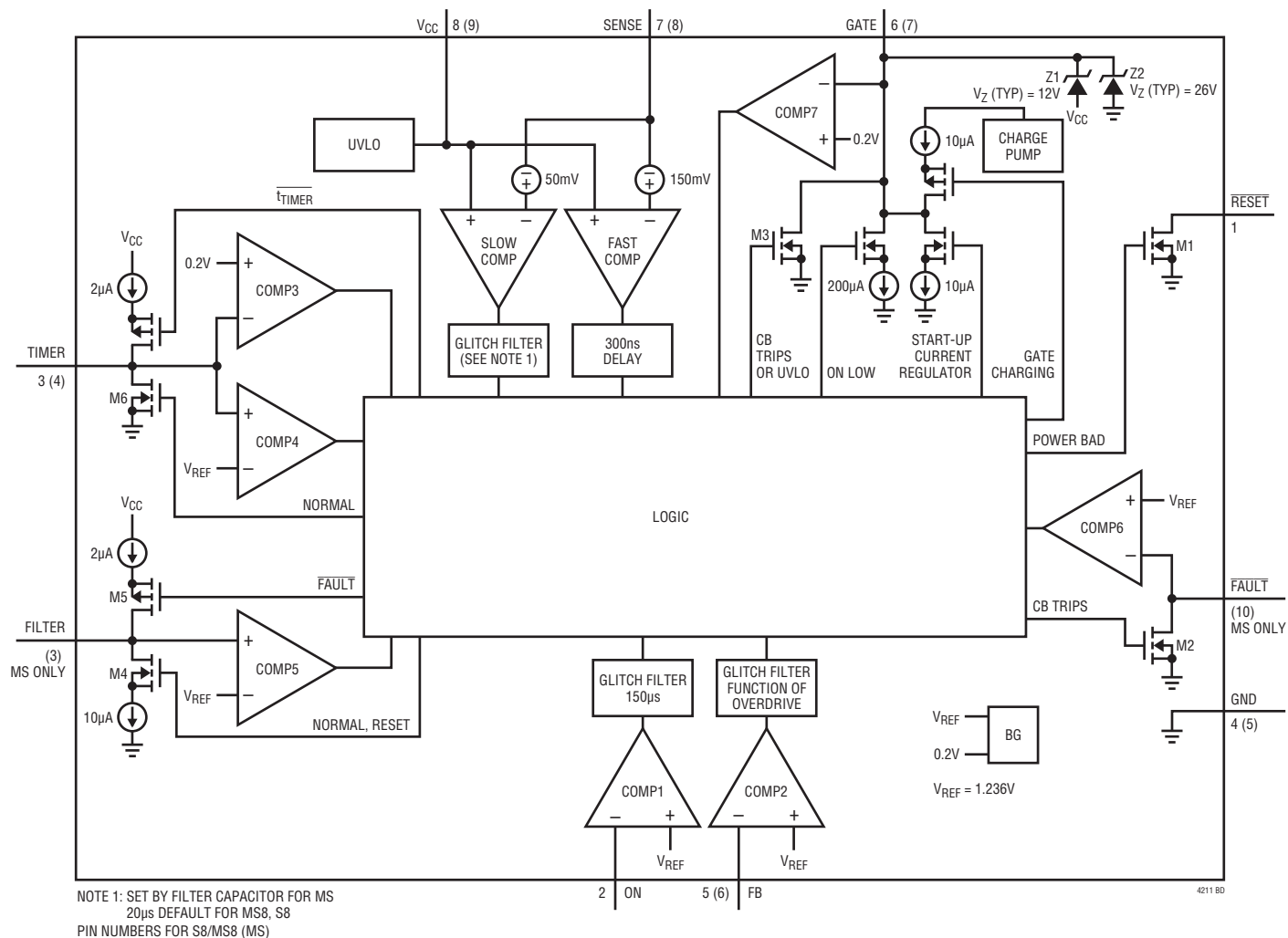
**$V_{\text{CC}}$  (Pin 8/Pin 9):** This is the positive supply input to the LTC4211. The LTC4211 operates from  $2.5\text{V} < V_{\text{CC}} < 16.5\text{V}$ , and the supply current is typically 1mA. An internal undervoltage lockout circuit disables the device until the voltage at  $V_{\text{CC}}$  exceeds 2.3V.

**$\overline{\text{FAULT}}$  (Not available on S8/MS8, Pin 10 MS):**  $\overline{\text{FAULT}}$  is both an input and an output. Connected to this pin are an analog comparator (COMP6) and an open-drain N-channel FET. During normal operation, if COMP6 is driven below 1.236V, the electronic circuit breaker trips and the GATE pin pulls low. Typically, a 10k pull-up resistor connects to the  $\overline{\text{FAULT}}$  pin. This pull-up is required to allow the LTC4211 to begin a second timing cycle ( $V_{\overline{\text{FAULT}}} > 1.286$ ) and start-up properly. This also allows the use of the  $\overline{\text{FAULT}}$  pin as a status output. Under normal operating conditions, the  $\overline{\text{FAULT}}$  output is a logic high. Two conditions cause an active low on  $\overline{\text{FAULT}}$ : (1) the LTC4211's electronic circuit breaker trips because of an output short circuit causing a fast output overcurrent transient (FAST COMP trips circuit breaker); or (2)  $V_{\text{FILTER}} > 1.236\text{V}$ . The  $\overline{\text{FAULT}}$  output is driven to logic low and is latched logic low until the ON pin is driven to logic low for 150 $\mu\text{s}$  (the  $t_{\text{RESET}}$  duration).

**FILTER (Not available S8/MS8, Pin 3 MS):** Overcurrent Fault Timing Pin and Overvoltage Fault Set pin. With a capacitor connected from this pin to ground, the SLOW COMP's response time can be adjusted. In the S8/MS8 version of the LTC4211, the FILTER pin is not available and the delay time from overcurrent detect to GATE OFF is fixed at 20 $\mu\text{s}$ .

# LTC4211

## BLOCK DIAGRAM



## OPERATION

### HOT CIRCUIT INSERTION

When circuit boards are inserted into or removed from live backplanes, the supply bypass capacitors can draw huge transient currents from the backplane power bus as they charge. The transient current can cause permanent damage to the connector pins as well as cause glitches on the system supply, causing other boards in the system to reset.

The LTC4211 is designed to turn a printed circuit board's supply voltages ON and OFF in a controlled manner, allowing the circuit board to be safely inserted or removed from a live backplane. The device provides a system reset signal to indicate when board supply voltage drops below a predetermined level, as well as a dual function fault monitor.

### OUTPUT VOLTAGE MONITOR

The LTC4211 uses a 1.236V bandgap reference, precision voltage comparator and an external resistor divider to monitor the output supply voltage as shown in Figure 1.

The operation of the supply monitor in normal mode is illustrated in Figure 2. When the voltage at the FB pin drops below its reset threshold (1.236V), the comparator

COMP2 output goes high. After a glitch filter delay,  $\overline{\text{RESET}}$  is pulled low (Time Point 1). When the voltage at the FB pin rises above its reset threshold (1.239V), COMP2's output goes low and a timing cycle starts (Time Point 4). After a complete timing cycle,  $\overline{\text{RESET}}$  is pulled high by the external pull-up resistor. If the FB pin rises above the reset threshold for less than a timing cycle, the  $\overline{\text{RESET}}$  output remains low (Time Points 2 to 3).

As shown in Figure 5, the LTC4211's  $\overline{\text{RESET}}$  pin is logic low during any undervoltage lockout condition and during the initial insertion of a PC board. Under normal operation,  $\overline{\text{RESET}}$  goes to logic high at the end of the soft-start cycle only after the FB pin voltage rises above its reset threshold of 1.239V.

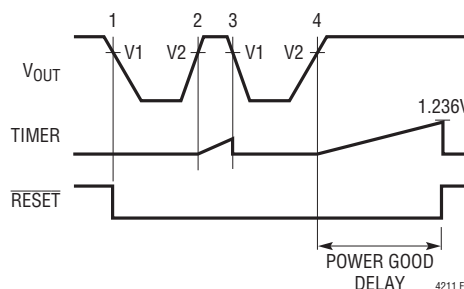


Figure 2. Supply Monitor Waveforms in Normal Mode

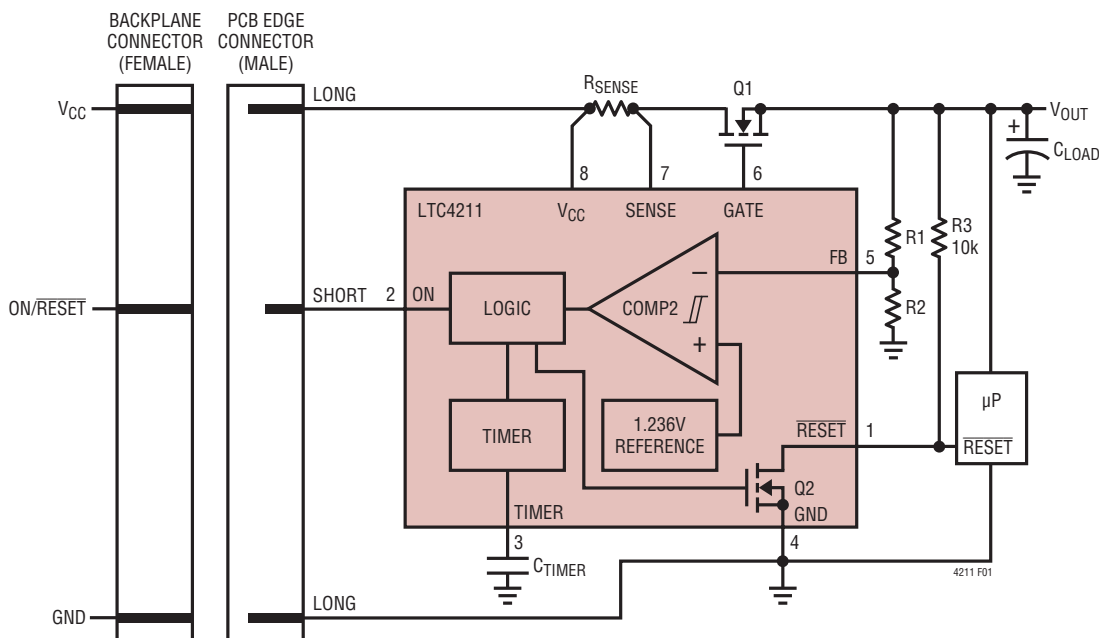


Figure 1. Supply Voltage Monitor Block Diagram

## OPERATION

### UNDERVOLTAGE LOCKOUT

The LTC4211's power-on reset circuit initializes the start-up procedure and ensures the chip is in the proper state if the input supply voltage is too low. If the supply voltage falls below 2.18V, the LTC4211 is in undervoltage lockout (UVLO) mode, and the GATE pin is pulled low. Since the UVLO circuitry uses hysteresis, the chip restarts after the supply voltage rises above 2.3V and the ON pin goes high.

In addition, users can utilize the ON comparator (COMP1) or the FAULT comparator (COMP6) to effectively program a higher undervoltage lockout level. Figure 3 shows how the external resistor divider at the ON pin programs the system's undervoltage lockout voltage. The system will enter the plug-in cycle after the ON pin rises above 1.316V. The resistor divider sets the circuit to turn on when  $V_{CC}$  reaches around 79% of its final value. If a different turn on  $V_{CC}$  voltage is desired change the resistor divider values accordingly. Alternatively, the  $\overline{\text{FAULT}}$  comparator can be used to configure the external undervoltage lockout level. If the  $\overline{\text{FAULT}}$  comparator is used for this purpose, the system will wait for the input voltage to increase above the level set by the user before starting the second timing cycle. Also, if the input voltage drops below the set level in normal operating mode, the user must cycle the ON pin or  $V_{CC}$  to restart the system.

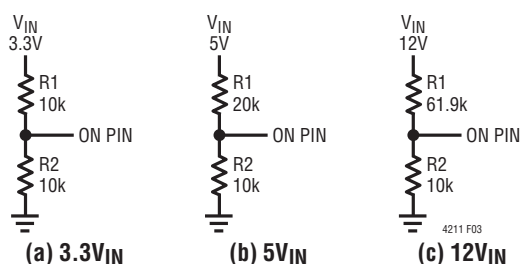


Figure 3. ON Pin Sets the Undervoltage Lockout Voltage Externally

### GLITCH FILTER FOR RESET

The LTC4211 has a glitch filter to prevent transients on the FB pin from generating a system reset. The relationship between glitch filter time and the FB transient voltage is shown in Figure 4.

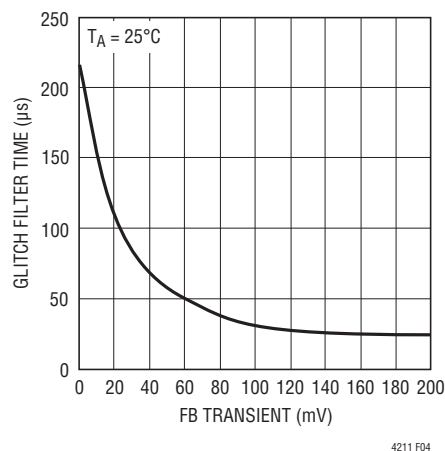


Figure 4. FB Comparator Glitch Filter Time vs Feedback Transient Voltage

### SYSTEM TIMING

System timing for the LTC4211 is generated at the TIMER pin (see the Block Diagram). If the LTC4211's internal timing circuit is off, an internal N-channel FET connects the TIMER pin to GND. If the timing circuit is enabled, an internal 2μA current source is then connected to the TIMER pin to charge  $C_{\text{TIMER}}$  at a rate given by Equation 1:

$$C_{\text{TIMER}} \text{ Charge-Up Rate} = \frac{2\mu\text{A}}{C_{\text{TIMER}}} \quad (1)$$

When the TIMER pin voltage reaches COMP4's threshold of 1.236V, the TIMER pin is reset to GND. Equation 2 gives an expression for the timer period:

$$t_{\text{TIMER}} = 1.236\text{V} \cdot \frac{C_{\text{TIMER}}}{2\mu\text{A}} \quad (2)$$

As a design aid, the LTC4211's timer period as a function of the  $C_{\text{TIMER}}$  using standard values from 3.3nF to 0.33μF is shown in Table 1.

## OPERATION

Table 1.  $t_{\text{TIMER}}$  vs  $C_{\text{TIMER}}$

| $C_{\text{TIMER}}$   | $t_{\text{TIMER}}$ |
|----------------------|--------------------|
| 0.0033 $\mu\text{F}$ | 2.0ms              |
| 0.0047 $\mu\text{F}$ | 2.9ms              |
| 0.0068 $\mu\text{F}$ | 4.2ms              |
| 0.0082 $\mu\text{F}$ | 5.1ms              |
| 0.01 $\mu\text{F}$   | 6.2ms              |
| 0.015 $\mu\text{F}$  | 9.3ms              |
| 0.022 $\mu\text{F}$  | 13.6ms             |
| 0.033 $\mu\text{F}$  | 20.4ms             |
| 0.047 $\mu\text{F}$  | 29.0ms             |
| 0.068 $\mu\text{F}$  | 42.0ms             |
| 0.082 $\mu\text{F}$  | 50.7ms             |
| 0.1 $\mu\text{F}$    | 61.8ms             |
| 0.15 $\mu\text{F}$   | 92.7ms             |
| 0.22 $\mu\text{F}$   | 136ms              |
| 0.33 $\mu\text{F}$   | 204ms              |

The  $C_{\text{TIMER}}$  value is vital to ensure a proper start-up and reliable operation. A system may not start up if a timing period is set too short relative to the time needed for the output voltage to ramp up from zero to its rated value. Conversely, this timing period should not be too long as an output short can occur at start-up causing the external MOSFET to overheat. A good starting point is to set  $C_{\text{TIMER}} = 10\text{nF}$  and adjust its value accordingly to suit the specific applications.

## OPERATING SEQUENCE

### Power-Up, Start-Up Check and Plug-In Timing Cycle

The sequence of operation for the LTC4211 is illustrated in the timing diagram of Figure 5. When a PC board is inserted into a live backplane, the LTC4211 first performs

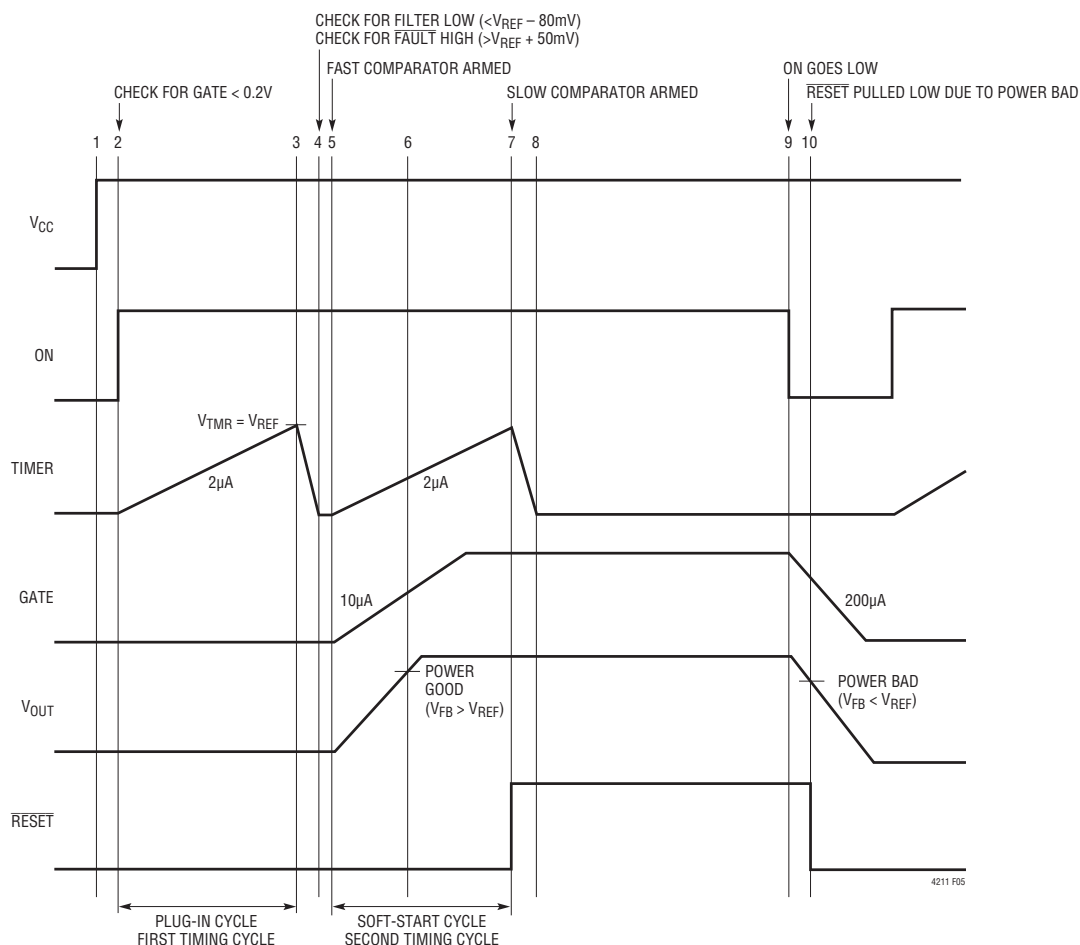


Figure 5. Normal Power-Up Sequence

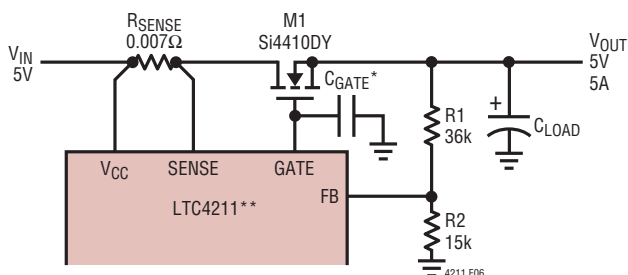
## OPERATION

a start-up check to make sure the supply voltage is above its 2.3V UVLO threshold (see Time Point 1). If the input supply voltage is valid, the gate of the external pass transistor is pulled to ground by the internal 200μA current source connected at the GATE pin. The TIMER pin is held low by an internal N-channel pull-down transistor (see M6, LTC4211 Block Diagram) and the FILTER pin voltage is pulled to ground by an internal 10μA current source.

Once  $V_{CC}$  and ON (the ON pin is >1.316) are valid, the LTC4211 checks to make sure that GATE is OFF ( $V_{GATE} < 0.2V$ ) at Time Point 2. An internal timing circuit is enabled and the TIMER pin voltage ramps up at the rate described by Equation 1. At Time Point 3 (the timing period programmed by  $C_{TIMER}$ ), the TIMER pin voltage equals  $V_{TMR}$  (1.236V). Next, the TIMER pin voltage ramps down to Time Point 4 where the LTC4211 performs two checks: (1) FILTER pin voltage is low ( $V_{FILTER} < 1.156V$ ) and (2)  $\overline{FAULT}$  pin voltage is high ( $V_{\overline{FAULT}} > 1.286V$ ). If both conditions are met, the LTC4211 begins a second timing (soft-start) cycle.

### Second Timing (Soft-Start) Cycle

At the beginning of the second timing cycle (Time Point 5), the LTC4211's FAST COMP is armed and an internal 10μA current source working with an internal charge pump provides the gate drive to the external pass transistor. The LTC4211 automatically limits the inrush current in one of two ways: by controlling the GATE pin voltage slew rate or by actively limiting the inrush current. If GATE voltage slew rate control is preferred, an external capacitor  $C_{GATE}$  can be used from GATE to ground, as shown in Figure 6.



\*VALUES  $\leq 150nF$  SUGGESTED  
 \*\*ADDITIONAL DETAILS OMITTED FOR CLARITY

$$V_{GATE} \text{ SLEW RATE CONTROL}$$

$$\frac{dV_{GATE}}{dt} = \left( \frac{10\mu A}{C_{GATE}} \right)$$

**Figure 6. Using an External Capacitor at GATE for GATE Voltage Slew Rate Control**

An expression for the GATE voltage slew rate is given by Equation 3:

$$V_{GATE} \text{ Slew Rate, } \frac{dV_{GATE}}{dt} = \frac{10\mu A}{C_{GATE}} \quad (3)$$

Adding  $C_{GATE}$  slows the GATE voltage slew rate at the expense of slower system turn-on and turn-off time. Should this technique be used, values for  $C_{GATE}$  less than 150nF are recommended.

The inrush current being delivered to the load while the GATE is ramping is dependent on  $C_{LOAD}$  and  $C_{GATE}$ . Equation 4 gives an expression for the inrush current during the second timing cycle:

$$I_{INRUSH} = \frac{dV_{GATE}}{dt} \cdot C_{LOAD} = 10\mu A \cdot \frac{C_{LOAD}}{C_{GATE}} \quad (4)$$

For example, if  $C_{GATE} = 3300pF$  and  $C_{LOAD} = 2000\mu F$ , the inrush current charging  $C_{LOAD}$  is:

$$I_{INRUSH} = 10\mu A \cdot \frac{2000\mu F}{0.0033\mu F} = 6.06A \quad (5)$$

At Time Point 6, the output voltage trips COMP2's threshold, signaling an output voltage "power good" condition. At Time Point 7,  $\overline{RESET}$  is asserted high, SLOW COMP is armed and the LTC4211 enters a fault monitor mode. The TIMER voltage then ramps down to Time Point 8.

### Power-Off Cycle

As shown at Time Point 9, an external hard reset is initiated by pulling the ON pin low ( $V_{ON} < 1.236V$ ). The GATE pin voltage is ramped to ground by the internal 200μA current source, discharging  $C_{GATE}$  and turning off the pass transistor. As  $C_{LOAD}$  discharges, the output voltage crosses COMP2's threshold, signaling a "power bad" condition at Time Point 10. At this point,  $\overline{RESET}$  is asserted low.

## OPERATION

### SOFT-START WITH CURRENT LIMITING

During the second timing cycle, the inrush current was described by Equation 4. Note that there is a one-to-one correspondence in the inrush current to  $C_{LOAD}$ . If the inrush current is large enough to cause a voltage drop greater than 50mV across the sense resistor, an internal servo loop controls the operation of the 10 $\mu$ A current source at the GATE pin to regulate the load current to:

$$I_{LIMIT(SOFTSTART)} = \frac{50mV}{R_{SENSE}} \quad (6)$$

For example, the inrush current is limited to 5A when  $R_{SENSE} = 0.01\Omega$ .

In this fashion, the inrush current is controlled and  $C_{LOAD}$  is charged up slowly during the soft-start cycle.

The timing diagram in Figure 7 illustrates the operation of the LTC4211 in a normal power-up sequence with limited inrush current as described by Equation 6. At Time Point 5, the GATE pin voltage begins to ramp and the power MOSFET starts to charge  $C_{LOAD}$ . At Time Point 5A, the inrush current causes a 50mV voltage drop across  $R_{SENSE}$  and the internal servo loop engages, limiting the inrush current to a fixed level. At Time Point 6, the GATE pin voltage continues to ramp as  $C_{LOAD}$  charges until  $V_{OUT}$  reaches its final value. The charging current reduces, and the internal servo loop disengages. At the end of the soft-start cycle (Time Point 7),  $\overline{RESET}$  is high and SLOW COMP is armed.

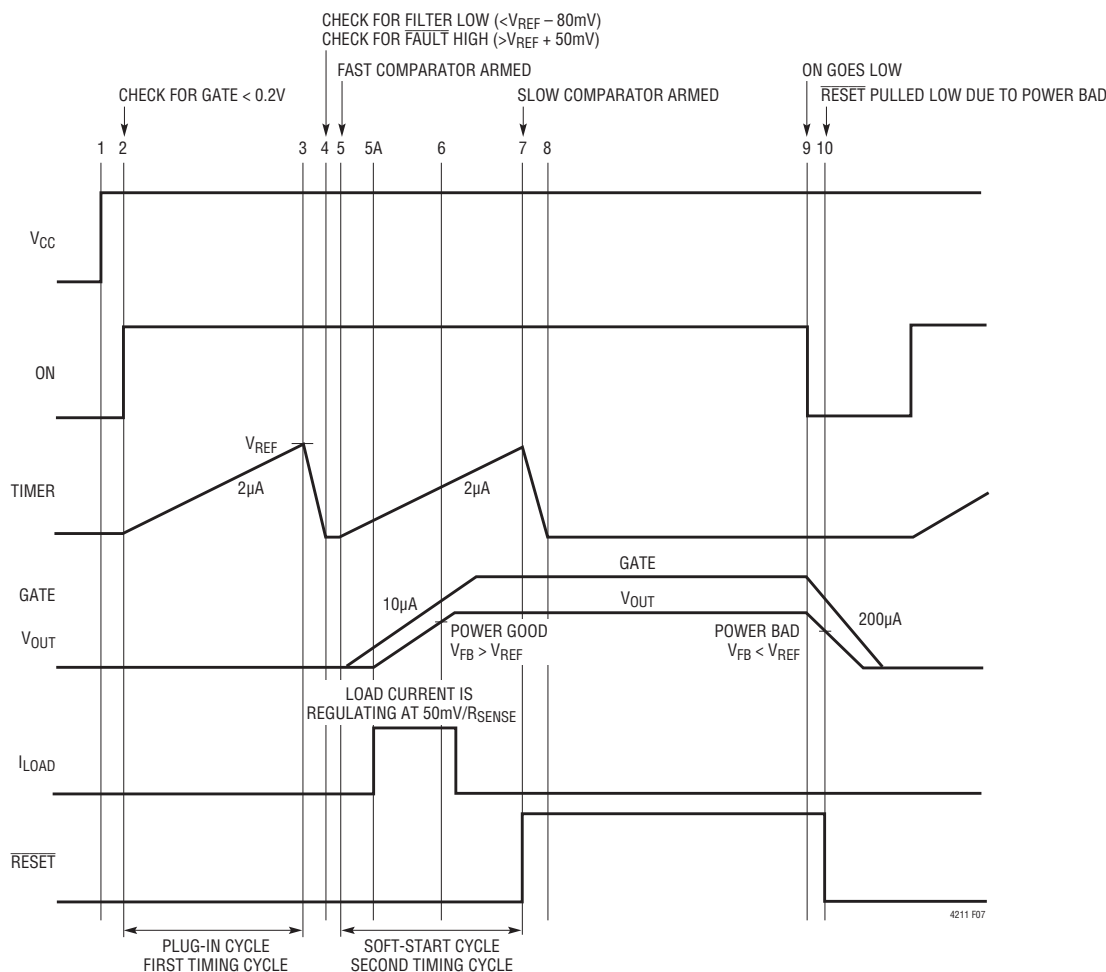


Figure 7. Normal Power-Up Sequence (with Current Limiting in Second Timing Cycle)

## OPERATION

### FREQUENCY COMPENSATION AT SOFT-START

If the external gate capacitance is greater than 600pF, no external gate capacitor is required at GATE to stabilize the internal current-limiting loop during soft-start. Otherwise, connect a gate capacitor between the GATE pin and ground to increase the total gate capacitance to be equal to or above 600pF. The servo loop that controls the external MOSFET during current limiting has a unity-gain frequency of about 105kHz and phase margin of 80° for external MOSFET gate input capacitances to 2.5nF.

### USING AN EXTERNAL GATE CAPACITOR

In addition to reducing the inrush current (Equation 4), an external gate capacitor (Figure 6) may also be useful to decrease or eliminate current spikes through the MOSFET when power is first applied. At power-up, the instantaneous input voltage step attempts to pull the MOSFET gate up through the MOSFET's drain-to-gate capacitance. If the MOSFET's  $C_{GS}$  is small, the gate can be pulled up high enough to turn on the MOSFET, thereby allowing a current spike to the output. This event occurs during the time that the LTC4211 is coming out of UVLO and getting its intelligence to hold the GATE pin low. An external capacitor attenuates the voltage to which the GATE is pulled up and eliminates the current spike. The value required is dependent on the MOSFET capacitance specifications. In typical applications, this capacitor is not required.

### ELECTRONIC CIRCUIT BREAKER

The LTC4211 features an electronic circuit breaker function that protects against externally-generated fault conditions and shorts or excessive load current and can also be configured to protect against input supply overvoltage. If the circuit breaker trips, the GATE pin is immediately pulled to ground, the external N-channel MOSFET is quickly turned OFF and  $\overline{\text{FAULT}}$  is latched low.

The circuit breaker trips whenever the voltage across the sense resistor exceeds two different levels, set by the LTC4211's SLOW COMP and FAST COMP thresholds (see Block Diagram). The SLOW COMP trips the circuit

breaker if the voltage across the SENSE resistor ( $V_{CC} - V_{\text{SENSE}} = V_{CB}$ ) is greater than 50mV for 20 $\mu$ s. There may be applications where this comparator's response time is not long enough, for example, because of excessive supply voltage noise. To adjust the response time of the SLOW COMP, the MS version of the LTC4211 is chosen and a capacitor is used at the LTC4211's FILTER pin (see section on Adjusting SLOW Comp's Response Time). The FAST COMP trips the circuit breaker to protect against fast load overcurrents if the transient voltage across the sense resistor is greater than 150mV for 300ns. The response time of the LTC4211's FAST COMP is fixed.

The timing diagram of Figure 7 illustrates when the LTC4211's electronic circuit breaker is armed. After the first timing cycle, the LTC4211's FAST COMP is armed at Time Point 5. Arming FAST COMP at Time Point 5 ensures that the system is protected against a short-circuit condition during the second timing cycle. At Time Point 7, SLOW COMP is armed when the internal control loop is disengaged.

The timing diagrams in Figures 8 and 9 illustrate the operation of the LTC4211 when the load current conditions exceed the thresholds of the FAST COMP ( $V_{CB(\text{FAST})} > 150\text{mV}$ ) and SLOW COMP ( $V_{CB(\text{SLOW})} > 50\text{mV}$ ), respectively.

### RESETTING THE ELECTRONIC CIRCUIT BREAKER

Once the LTC4211's circuit breaker is tripped,  $\overline{\text{FAULT}}$  is asserted low and the GATE pin is pulled to ground. The LTC4211 remains latched OFF in this fault state until the external fault is cleared. To clear the internal fault detect circuitry and to restart the LTC4211, its ON pin must be driven low ( $V_{ON} < 1.236\text{V}$ ) for at least 150 $\mu$ s, after which time  $\overline{\text{FAULT}}$  goes high. Toggling the ON pin from low to high ( $V_{ON} > 1.316\text{V}$ ) initiates a restart sequence in the LTC4211. The timing diagram in Figure 10 illustrates a start-up sequence where the LTC4211 is powered up into a load overcurrent condition. Note that the circuit breaker trips at Time Point B and is reset at Time Point 9A.

# OPERATION

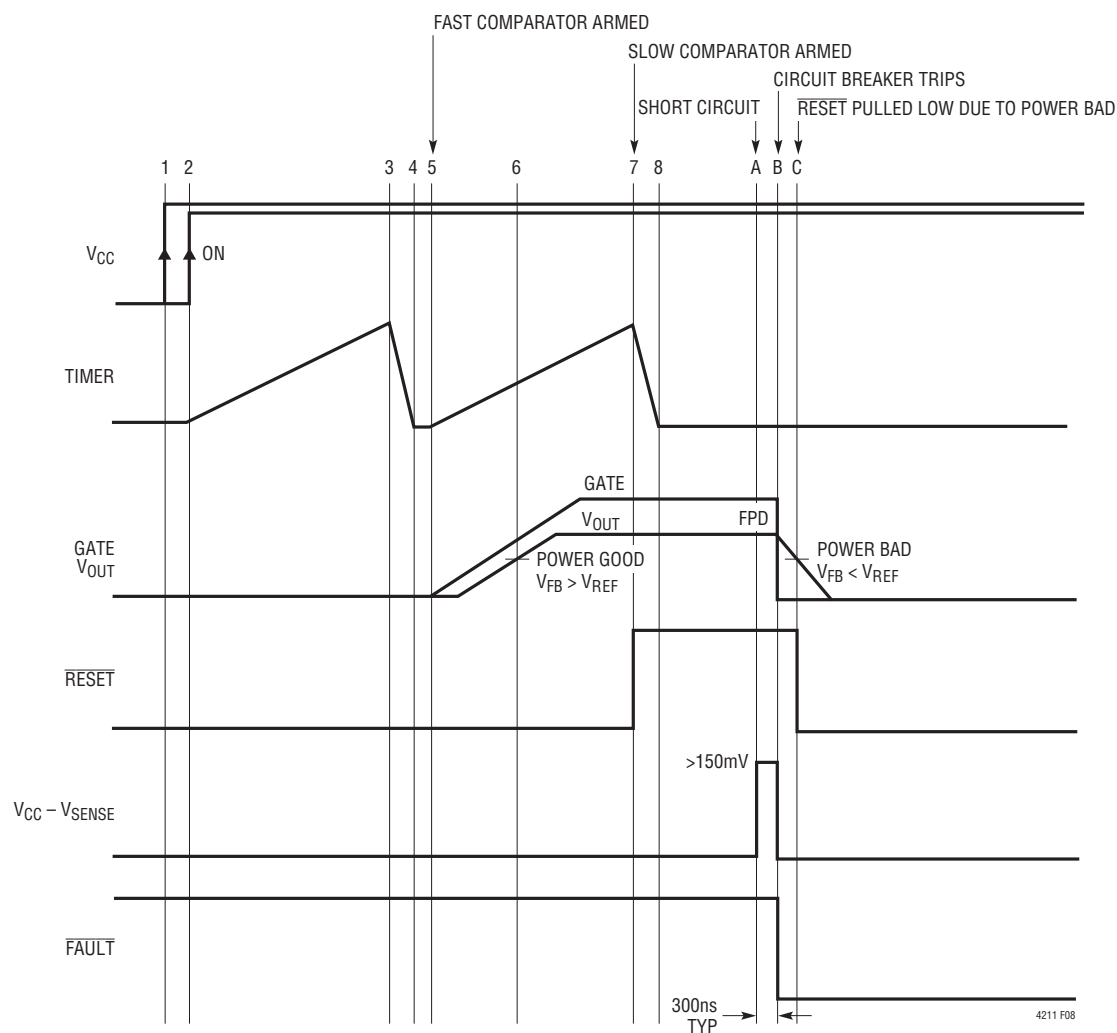


Figure 8. Output Short Circuit Causes Fast Comparator to Trip the Circuit Breaker

## OPERATION

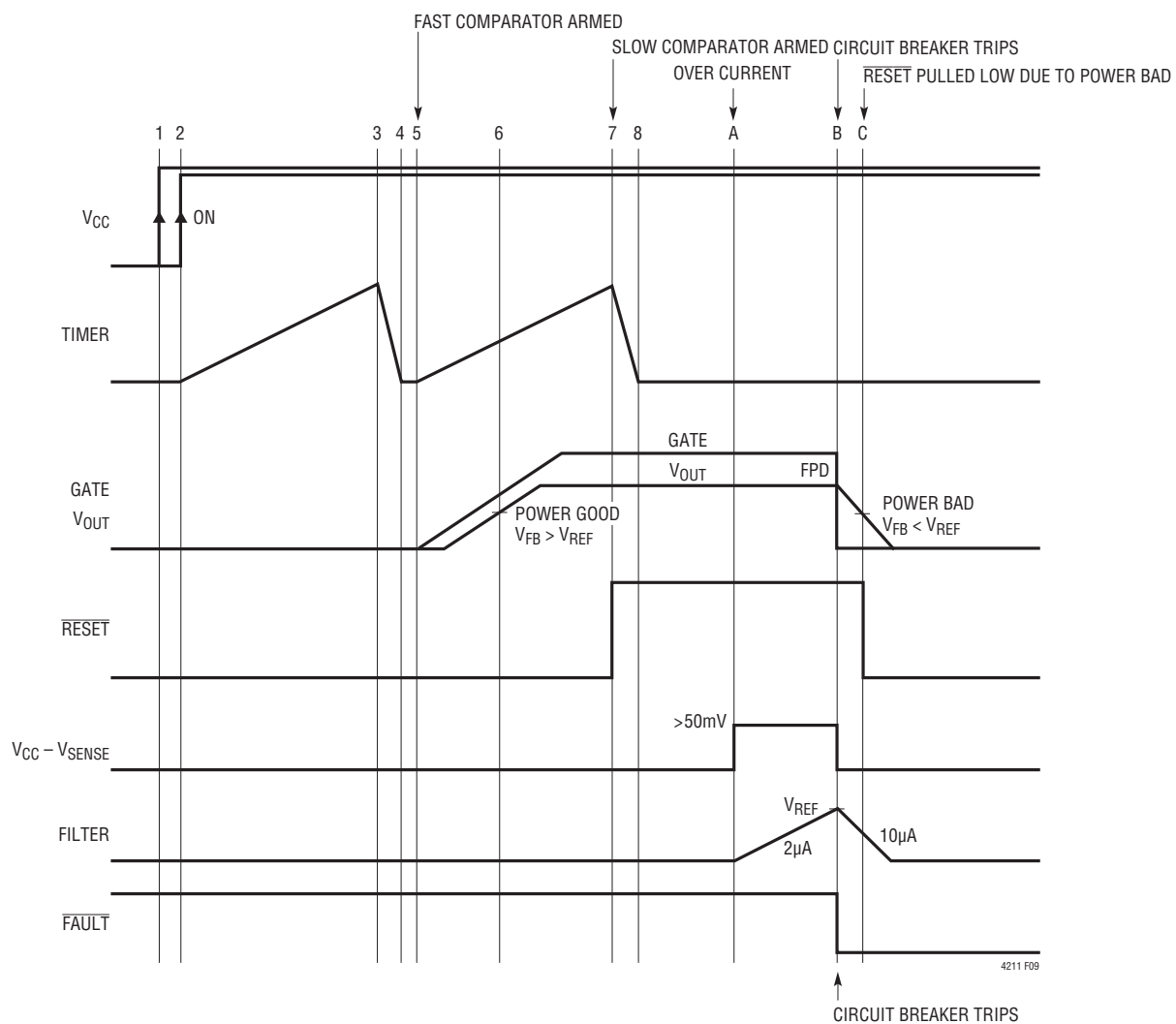


Figure 9. Mild Overcurrent Slow Comparator Trips the Circuit Breaker After Filter Programming Period

## OPERATION

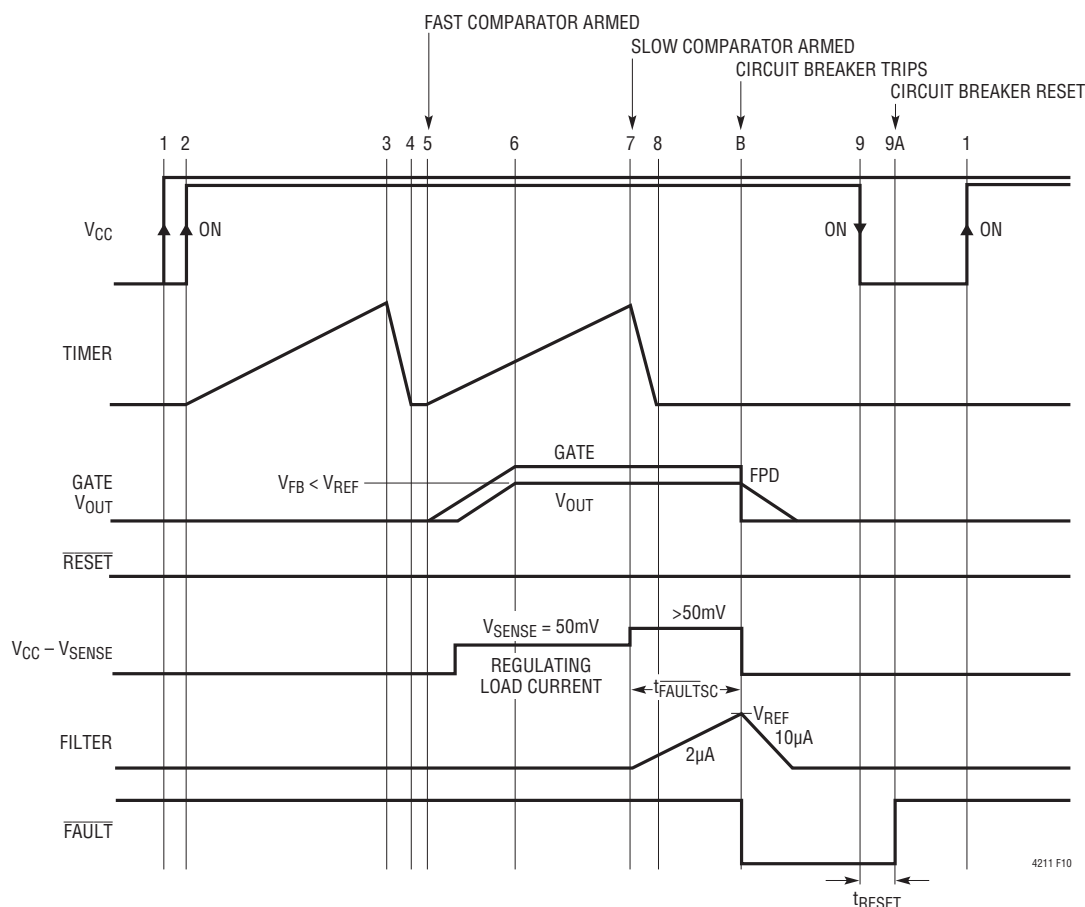


Figure 10. Power-Up in Overcurrent, Slow Comparator Trips the Circuit Breaker

### ADJUSTING SLOW COMP'S RESPONSE TIME

The response time of SLOW COMP is adjusted using a capacitor connected from the LTC4211's FILTER pin to ground. If this pin is left unused, SLOW COMP's delay defaults to 20μs. During normal operation, the FILTER output pin is held low as an internal 10μA pull-down current source is connected to this pin by transistor M4. This pull-down current source is turned off when an overcurrent load condition is detected by SLOW COMP. During an overcurrent condition, the internal 2μA pull-up current source is connected to the FILTER pin by transistor M5, thereby charging  $C_{FILTER}$ . As the charge on the capacitor accumulates, the voltage across  $C_{FILTER}$  increases. Once the FILTER pin voltage increases to 1.236V, the electronic circuit breaker trips and the LTC4211's

GATE pin is switched quickly to ground by transistor M3. After the circuit breaker is tripped, M5 is turned OFF, M4 is turned ON and the 10μA pull-down current then holds the FILTER pin voltage low.

The SLOW COMP response time from an overcurrent fault condition to when the circuit breaker trips (GATE OFF) is given by Equation 7:

$$t_{SLOWCOMP} = 1.236V \cdot \frac{C_{FILTER}}{2\mu A} + 20\mu s \quad (7)$$

For example, if  $C_{FILTER} = 1000pF$ , SLOW COMP's response time = 638μs. As a design aid, SLOW COMP's delay time ( $t_{SLOWCOMP}$ ) versus  $C_{FILTER}$  for standard values of  $C_{FILTER}$  from 100pF to 1000pF is illustrated in Table 2.

## OPERATION

**Table 2.  $t_{\text{SLOWCOMP}}$  vs  $C_{\text{FILTER}}$**

| $C_{\text{FILTER}}$ | $t_{\text{SLOWCOMP}}$ |
|---------------------|-----------------------|
| 100pF               | 82μs                  |
| 220pF               | 156μs                 |
| 330pF               | 224μs                 |
| 470pF               | 310μs                 |
| 680pF               | 440μs                 |
| 820pF               | 527μs                 |
| 1000pF              | 638μs                 |

### SENSE RESISTOR CONSIDERATIONS

The fault current level at which the LTC4211's internal electronic circuit breaker trips is determined by a sense resistor connected between the LTC4211's  $V_{\text{CC}}$  and SENSE pins and two separate trip points. The first trip point is set by the SLOW COMP's threshold,  $V_{\text{CB(SLOW)}} = 50\text{mV}$ , and occurs should a load current fault condition exist for more than 20μs. The current level at which the electronic circuit breaker trips is given by Equation 8:

$$I_{\text{TRIP(SLOW)}} = \frac{V_{\text{CB(SLOW)}}}{R_{\text{SENSE}}} = \frac{50\text{mV}}{R_{\text{SENSE}}} \quad (8)$$

The second trip point is set by the FAST COMP's threshold,  $V_{\text{CB(FAST)}} = 150\text{mV}$ , and occurs during fast load current transients that exist for 300ns or longer. The current level at which the circuit breaker trips in this case is given by Equation 9:

$$I_{\text{TRIP(FAST)}} = \frac{V_{\text{CB(FAST)}}}{R_{\text{SENSE}}} = \frac{150\text{mV}}{R_{\text{SENSE}}} \quad (9)$$

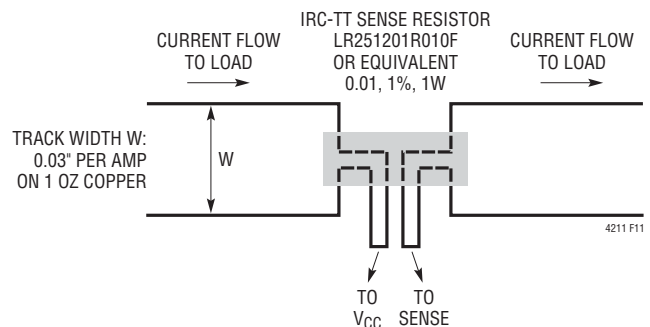
As a design aid, the currents at which the electronic circuit breaker trips for common values for  $R_{\text{SENSE}}$  are shown in Table 3.

**Table 3.  $I_{\text{TRIP(SLOW)}}$  and  $I_{\text{TRIP(FAST)}}$  vs  $R_{\text{SENSE}}$**

| $R_{\text{SENSE}}$ | $I_{\text{TRIP(SLOW)}}$ | $I_{\text{TRIP(FAST)}}$ |
|--------------------|-------------------------|-------------------------|
| 0.005Ω             | 10A                     | 30A                     |
| 0.006Ω             | 8.3A                    | 25A                     |
| 0.007Ω             | 7.1A                    | 21A                     |
| 0.008Ω             | 6.3A                    | 19A                     |
| 0.009Ω             | 5.6A                    | 17A                     |
| 0.01Ω              | 5A                      | 15A                     |

For proper circuit breaker operation, Kelvin-sense PCB connections between the sense resistor and the LTC4211's  $V_{\text{CC}}$  and SENSE pins are strongly recommended. The drawing in Figure 11 illustrates the correct way of making connections between the LTC4211 and the sense resistor. PCB layout should be balanced and symmetrical to minimize wiring errors. In addition, the PCB layout for the sense resistor should include good thermal management techniques for optimal sense resistor power dissipation.

The power rating of the sense resistor should accommodate steady-state fault current levels so that the component is not damaged before the circuit breaker trips. Table 4 in the Appendix lists sense resistors that can be used with the LTC4211's circuit breaker.



**Figure 11. Making PCB Connections to the Sense Resistor**

### CALCULATING CIRCUIT BREAKER TRIP CURRENT

For a selected  $R_{\text{SENSE}}$  value, the nominal load current that trips the circuit breaker is given by Equation 10:

$$I_{\text{TRIP(NOM)}} = \frac{V_{\text{CB(NOM)}}}{R_{\text{SENSE(NOM)}}} = \frac{50\text{mV}}{R_{\text{SENSE(NOM)}}} \quad (10)$$

The minimum load current that trips the circuit breaker is given by Equation 11.

$$I_{\text{TRIP(MIN)}} = \frac{V_{\text{CB(MIN)}}}{R_{\text{SENSE(MAX)}}} = \frac{40\text{mV}}{R_{\text{SENSE(MAX)}}} \quad (11)$$

where

$$R_{\text{SENSE(MAX)}} = R_{\text{SENSE(NOM)}} \cdot \left[ 1 + \left( \frac{R_{\text{TOL}}}{100} \right) \right]$$

## OPERATION

The maximum load current that trips the circuit breaker is given in Equation 12.

$$I_{\text{TRIP(MAX)}} = \frac{V_{\text{CB(MAX)}}}{R_{\text{SENSE(MIN)}}} = \frac{60\text{mV}}{R_{\text{SENSE(MIN)}}} \quad (12)$$

where

$$R_{\text{SENSE(MIN)}} = R_{\text{SENSE(NOM)}} \cdot \left[ 1 - \left( \frac{R_{\text{TOL}}}{100} \right) \right]$$

For example:

If a sense resistor with  $7\text{m}\Omega \pm 5\%$   $R_{\text{TOL}}$  is used for current limiting, the nominal trip current  $I_{\text{TRIP(NOM)}} = 7.1\text{A}$ . From Equations 11 and 12,  $I_{\text{TRIP(MIN)}} = 5.4\text{A}$  and  $I_{\text{TRIP(MAX)}} = 9.02\text{A}$  respectively.

For proper operation and to avoid the circuit breaker tripping unnecessarily, the minimum trip current ( $I_{\text{TRIP(MIN)}}$ ) must exceed the circuit's maximum operating load current. For reliability purposes, the operation at the maximum trip current ( $I_{\text{TRIP(MAX)}}$ ) must be evaluated carefully. If necessary, two resistors with the same  $R_{\text{TOL}}$  can be connected in parallel to yield an  $R_{\text{SENSE(NOM)}}$  value that fits the circuit requirements.

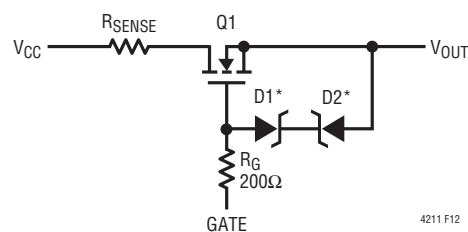
## POWER MOSFET SELECTION CRITERIA

To start the power MOSFET selection process, choose the maximum drain-to-source voltage,  $V_{\text{DS(MAX)}}$ , and the maximum drain current,  $I_{\text{D(MAX)}}$  of the MOSFET. The  $V_{\text{DS(MAX)}}$  rating must exceed the maximum input supply voltage (including surges, spikes, ringing, etc.) and the  $I_{\text{D(MAX)}}$  rating must exceed the maximum short-circuit current in the system during a fault condition. In addition, consider three other key parameters: 1) the required gate-source ( $V_{\text{GS}}$ ) voltage drive, 2) the voltage drop across the drain-to-source on resistance,  $R_{\text{DS(ON)}}$  and 3) the maximum junction temperature rating of the MOSFET.

Power MOSFETs are classified into three categories: standard MOSFETs ( $R_{\text{DS(ON)}}$  specified at  $V_{\text{GS}} = 10\text{V}$ ) logic-level MOSFETs ( $R_{\text{DS(ON)}}$  specified at  $V_{\text{GS}} = 5\text{V}$ ), and sub-logic-level MOSFETs ( $R_{\text{DS(ON)}}$  specified at  $V_{\text{GS}} = 2.5\text{V}$ ). The absolute maximum rating for  $V_{\text{GS}}$  is typically  $\pm 20\text{V}$  for

standard MOSFETs. However, the  $V_{\text{GS}}$  maximum rating for logic-level MOSFETs ranges from  $\pm 8\text{V}$  to  $\pm 20\text{V}$  depending upon the manufacturer and the specific part number. The LTC4211's GATE overdrive as a function of  $V_{\text{CC}}$  is illustrated in the Typical Performance curves. Logic-level and sub-logic-level MOSFETs are recommended for low supply voltage applications and standard MOSFETs can be used for applications where supply voltage is greater than  $4.75\text{V}$ .

Note that in some applications, the gate of the external MOSFET can discharge faster than the output voltage when the circuit breaker is tripped. This causes a negative  $V_{\text{GS}}$  voltage on the external MOSFET. Usually, the selected external MOSFET should have a  $\pm V_{\text{GS(MAX)}}$  rating that is higher than the operating input supply voltage to ensure that the external MOSFET is not destroyed by a negative  $V_{\text{GS}}$  voltage. In addition, the  $\pm V_{\text{GS(MAX)}}$  rating of the MOSFET must be higher than the gate overdrive voltage. Lower  $\pm V_{\text{GS(MAX)}}$  rating MOSFETs can be used with the LTC4211 if the GATE overdrive is clamped to a lower voltage. The circuit in Figure 12 illustrates the use of Zener diodes to clamp the LTC4211's GATE overdrive signal if lower voltage MOSFETs are used.



\*USER SELECTED VOLTAGE CLAMP  
(A LOW BIAS CURRENT ZENER DIODE IS RECOMMENDED)  
1N4688 (5V)  
1N4692 (7V): LOGIC-LEVEL MOSFET  
1N4695 (9V)  
1N4702 (15V): STANDARD-LEVEL MOSFET

**Figure 12. Optional Gate Clamp for Lower  $V_{\text{GS(MAX)}}$  MOSFETs**

The  $R_{\text{DS(ON)}}$  of the external pass transistor should be low to make its drain-source voltage ( $V_{\text{DS}}$ ) a small percentage of  $V_{\text{CC}}$ . At a  $V_{\text{CC}} = 2.5\text{V}$ ,  $V_{\text{DS}} + V_{\text{RSENSE}} = 0.1\text{V}$  yields 4% error at the output voltage. This restricts the choice of MOSFETs to very low  $R_{\text{DS(ON)}}$ . At higher  $V_{\text{CC}}$  voltages, the  $V_{\text{DS}}$  requirement can be relaxed in which case MOSFET package dissipation ( $P_{\text{D}}$  and  $T_{\text{J}}$ ) may limit the value of

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$R_{DS(ON)}$ . Table 5 lists some power MOSFETs that can be used with the LTC4211.

For reliable circuit operation, the maximum junction temperature ( $T_{J(MAX)}$ ) for a power MOSFET should not exceed the manufacturer's recommended value. This includes normal mode operation, start-up, current-limit and autoretry mode in a fault condition. Under normal conditions the junction temperature of a power MOSFET is given by Equation 13:

$$T_{J(MAX)} \leq T_{A(MAX)} + \theta_{JA} \cdot P_D \quad (13)$$

where

$$P_D = (I_{LOAD})^2 \cdot R_{DS(ON)}$$

$\theta_{JA}$  = junction-to-ambient thermal resistance

$T_{A(MAX)}$  = maximum ambient temperature

If a short circuit happens during start-up, the external MOSFET can experience a big single pulse energy. This is especially true if the applications only employ a small gate capacitor or no gate capacitor at all. Consult the safe operating area (SOA) curve of the selected MOSFET to ensure that the  $T_{J(MAX)}$  is not exceeded during start-up.

### USING STAGGERED PIN CONNECTORS

The LTC4211 can be used on either a printed circuit board or on the backplane side of the connector, and examples for both are shown in Figures 13 and 14. Printed circuit board edge connectors with staggered pins are recommended as the insertion and removal of circuit boards do sequence the pin connections. Supply voltage and ground connections on the printed circuit board should be wired to the edge connector's long pins or blades. Control and status signals (like RESET, FAULT and ON) passing through the card's edge connector should be wired to short length pins or blades.

### PCB CONNECTION SENSE

There are a number of ways to use the LTC4211's ON pin to detect whether the printed circuit board has been fully seated in the backplane before the LTC4211 commences a start-up cycle.

The first example is shown in the schematic on the front page of this data sheet. In this case, the LTC4211 is mounted on the PCB and a 20k/10k resistive divider is connected to the ON pin. On the edge connector, R1 is wired to a short pin. Until the connectors are fully mated, the ON pin is held low, keeping the LTC4211 in an OFF state. Once the connectors are mated, the resistive divider is connected to  $V_{CC}$ ,  $V_{ON} > 1.316V$  and the LTC4211 begins a start-up cycle.

In Figure 13, an LTC4211 is illustrated in a basic configuration on a PCB daughter card. The ON pin is connected to  $V_{CC}$  on the backplane through a 10k pull-up resistor once the card is seated into the backplane. R2 bleeds off any potential static charge which might exist on the backplane, the connector or during card installation.

A third example is shown in Figure 14 where the LTC4211 is mounted on the backplane. In this example, a 2N2222 transistor and a pair of resistors (R4, R5) form the PCB connection sense circuit. With the card out of the chassis, Q2's base is biased to  $V_{CC}$  through R5, biasing Q2 ON and driving the LTC4211's ON pin low. The base of Q2 is also wired to a socket on the backplane connector. When a card is firmly seated into the backplane, the base of Q2 is then grounded through a short pin connection on the card. Q2 is biased OFF, the LTC4211's ON pin is pulled-up to  $V_{CC}$  and a start-up cycle begins.

In the previous three examples, the connection sense was hard wired with no processor (low) interrupt capability. As illustrated in Figure 15, the addition of an inexpensive logic-level discrete MOSFET and a couple of resistors offers processor interrupt control to the connection sense. R4 keeps the gate of M2 at  $V_{CC}$  until the card is firmly mated to the backplane. A logic low for the  $\overline{ON}$ /OFF signal turns M2 OFF, allows the ON pin to pull high and turns on the LTC4211.

## APPLICATIONS INFORMATION

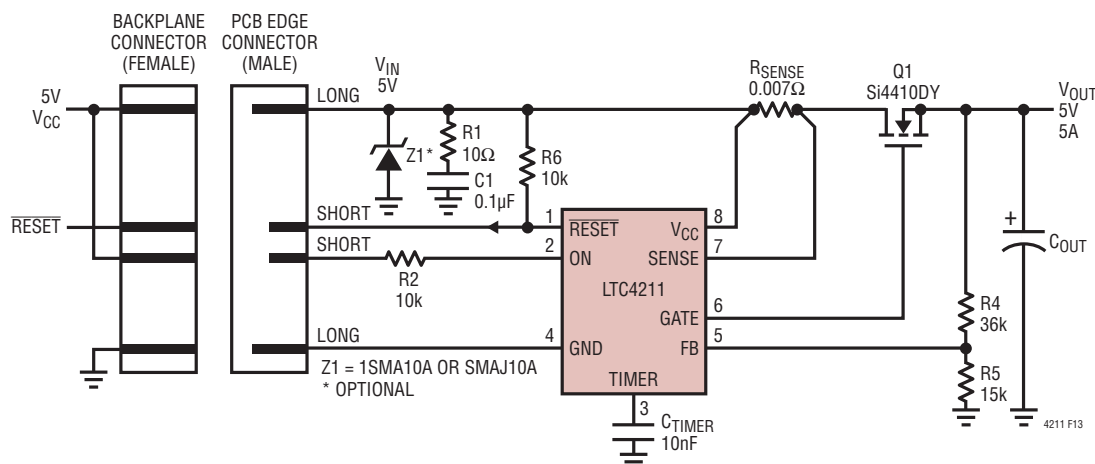


Figure 13. Hot Swap Controller On Daughter Board (Staggered Pin Connections)

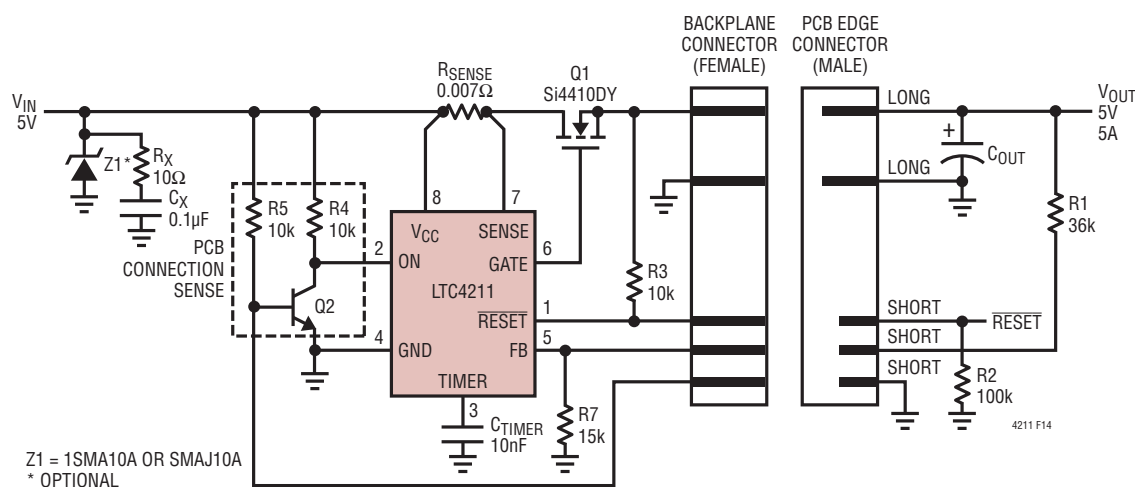


Figure 14. Hot Swap Controller on Backplane (Staggered Pin Connections)

A more elaborate connection sense scheme is shown in Figure 16. The bases of Q1 and Q2 are wired to short pins located on opposite ends of the edge connector because the installation/removal of printed circuit cards generally requires rocking the card back and forth. When  $V_{CC}$  makes connection, the bases of transistors Q1 and Q2 are pulled high, biasing them ON. When either one of them is ON, the LTC4211's ON pin is held low, keeping the LTC4211 OFF. When both the short base connector

pins of Q1 and Q2 finally mate to the backplane, their bases are grounded, biasing the transistors OFF. The ON pin voltage is then pulled high by R3 enabling the LTC4211 and a power-up cycle begins.

A software-initiated power-down cycle can be started by momentarily driving transistor M1 with a logic high signal. This in turn will drive the LTC4211's ON pin low. If the ON pin is held low for more than 8μs, the LTC4211's GATE pin is switched to ground.

## APPLICATIONS INFORMATION

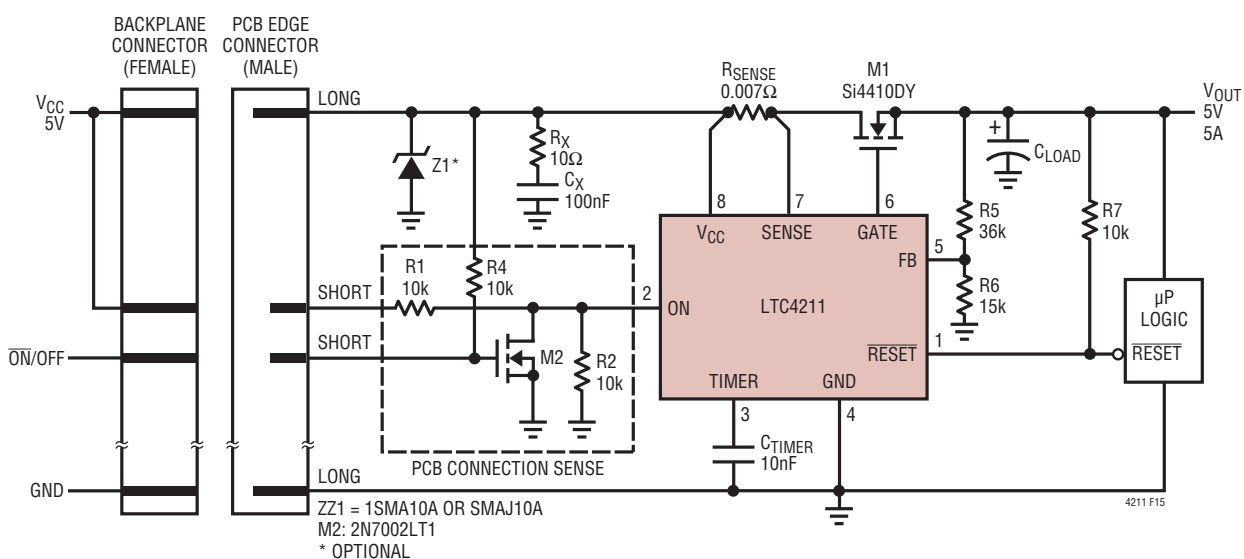


Figure 15. Connection Sense with ON/OFF Control

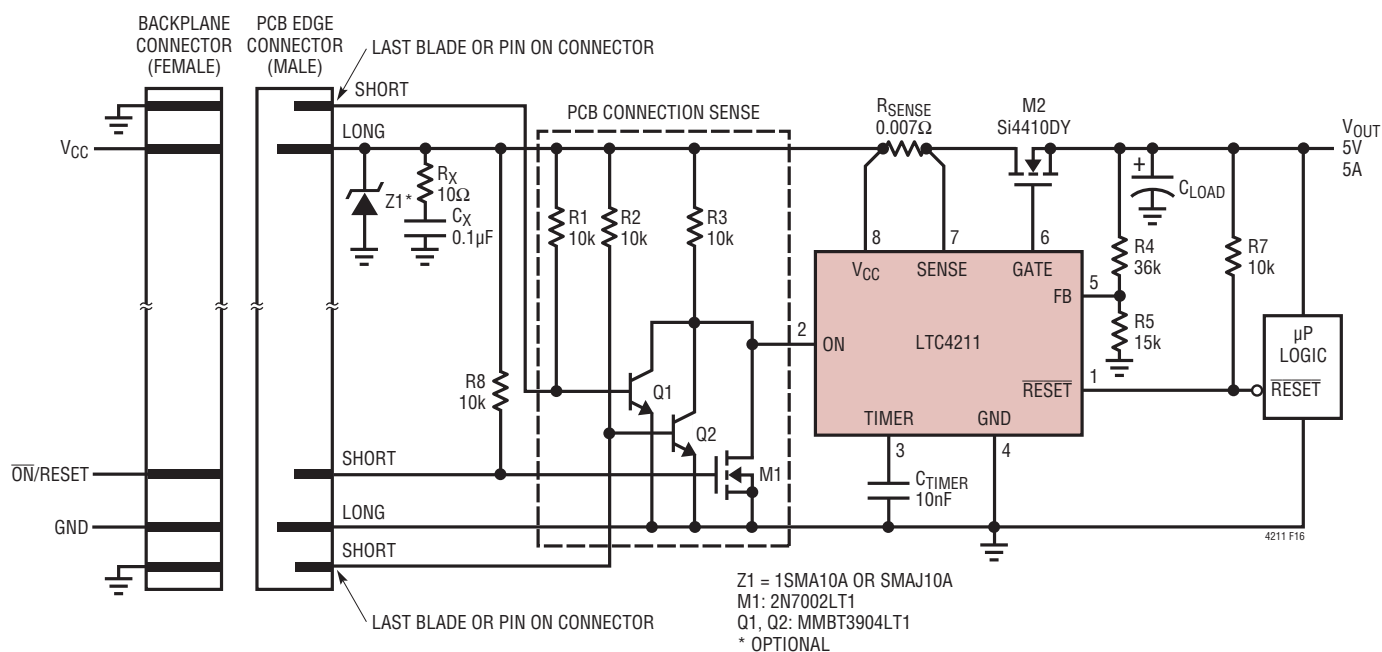


Figure 16. Connection Sense for Rocking the Daughter Board Back and Forth

## APPLICATIONS INFORMATION

### 12V Hot Swap Application

Figure 17 shows a 12V, 3A Hot Swap application circuit. The resistor divider R1/R2 programs the undervoltage lockout externally and allows the system to start up after  $V_{CC}$  increases above 9.46V. The resistor divider R3/R4 monitors  $V_{OUT}$  and signals the  $\overline{\text{RESET}}$  pin when  $V_{OUT}$  goes above 10.54V. Transient voltage suppressor Z1 and snubber network ( $C_X$ ,  $R_X$ ) are highly recommended to protect the 12V applications system from ringing and voltage spikes.  $R_G$  is recommended for  $V_{CC} > 10V$  and it can minimize high frequency parasitic oscillations in the power MOSFET.

### AUTORETRY AFTER A FAULT

To configure the LTC4211 to automatically retry after a fault condition, the  $\overline{\text{FAULT}}$  and ON pins can be connected to a pull-up resistor ( $R_{\text{AUTO}}$ ) to the supply, as shown in

Figure 18. In this case, the autoretry circuitry will attempt to restart the LTC4211 with a 50% duty cycle, as shown in the timing diagram of Figure 19. To prevent overheating the external MOSFET and other components during the autoretry sequence, adding a capacitor ( $C_{\text{AUTO}}$ ) to the circuit introduces an RC time constant ( $t_{\text{OFF}}$ ) that adjusts the autoretry duty cycle. Equation 14 gives the autoretry duty cycle, modified by this external time constant:

$$\text{Autoretry Duty Cycle} \approx \frac{t_{\text{TIMER}}}{t_{\text{OFF}} + 2 \cdot t_{\text{TIMER}}} \cdot 100\% \quad (14)$$

where  $t_{\text{TIMER}}$  = LTC4211 system timing (see TIMER function) and  $t_{\text{OFF}}$  is a time needed to charge capacitor  $C_{\text{AUTO}}$  from 0V to the ON pin threshold (1.316V).

In Figure 18 with  $R_{\text{AUTO}} = 1M$ , the external RC time constant is set at 1 second, the  $t_{\text{TIMER}}$  delay equals 6.2ms and the autoretry duty cycle drops from 50% to 2.5%.

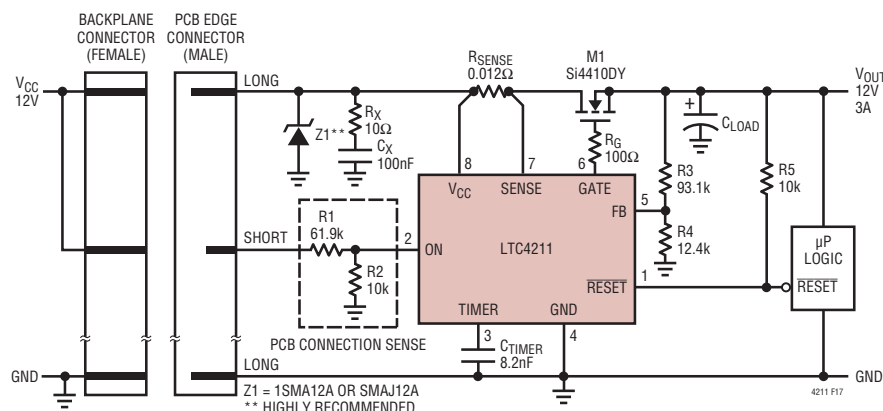


Figure 17. 12V Hot Swap Application

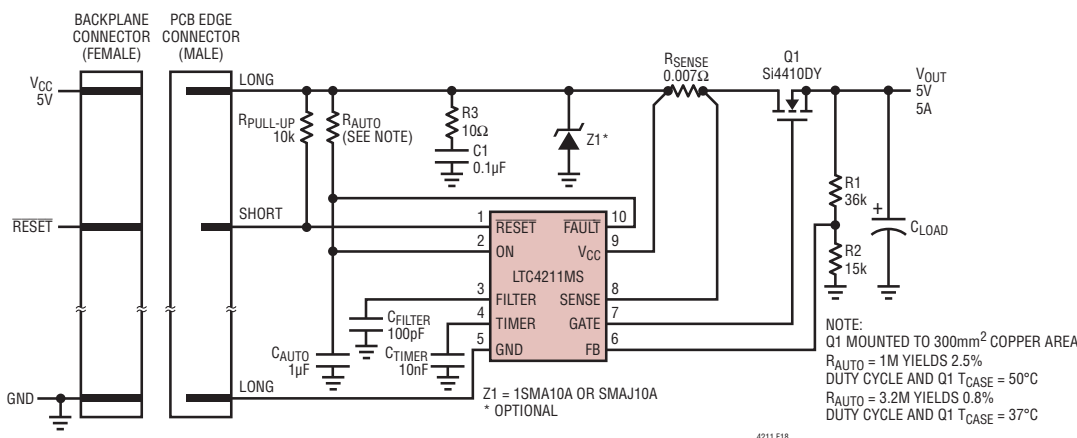


Figure 18. LTC4211MS Autoretry Application

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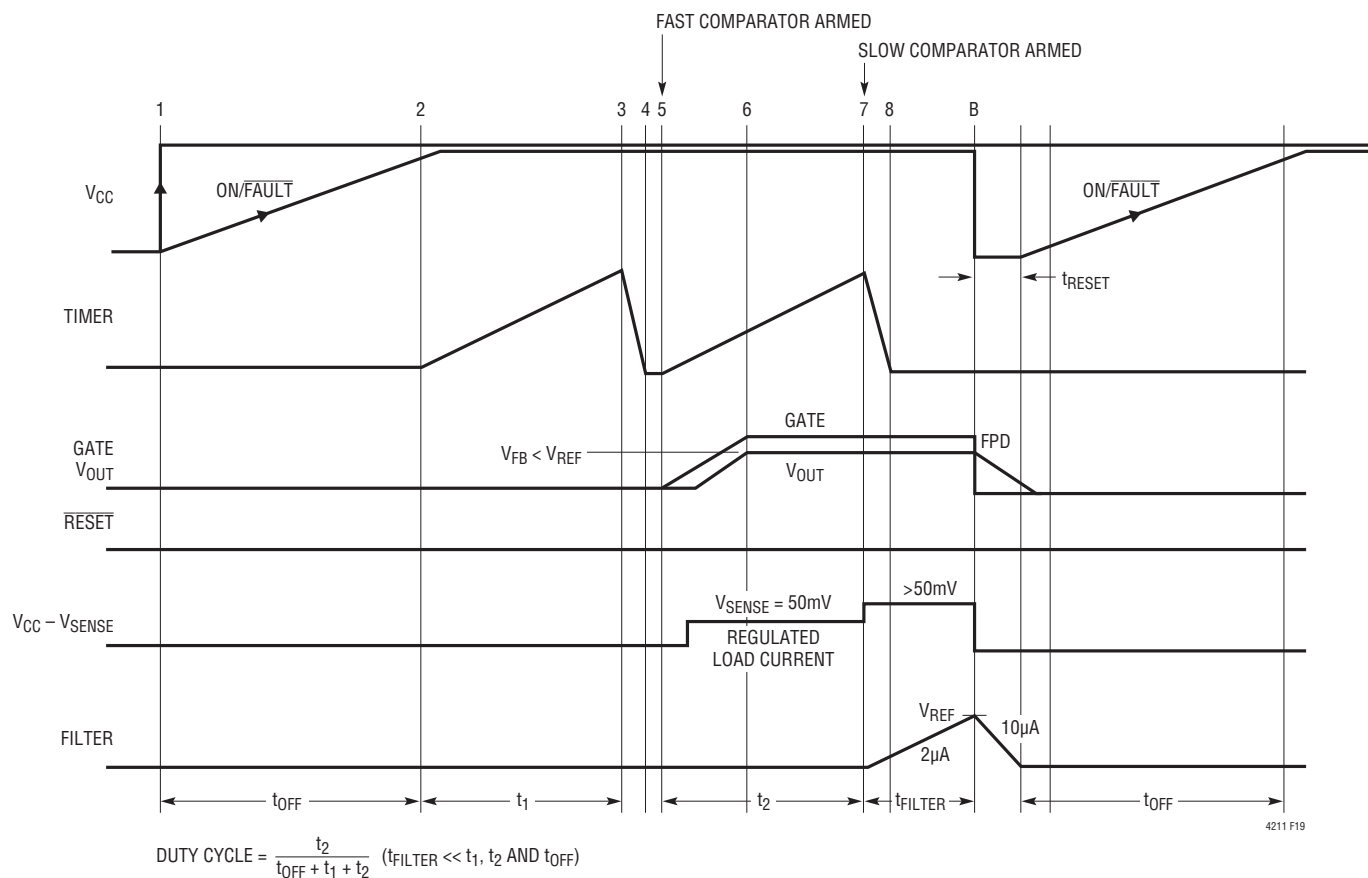


Figure 19. Autoretry Timing

To increase the RC delay, the user may either increase  $C_{AUTO}$  or  $R_{AUTO}$ . However, increasing  $C_{AUTO} > 2\mu\text{F}$  will actually limit the RC delay due to the reset sink-current capability of the  $\overline{\text{FAULT}}$  pin. Therefore, in order to increase the RC delay, it is more effective to either increase  $R_{AUTO}$  or to put a bleed resistor in parallel with  $C_{AUTO}$  to GND. For example, increasing  $R_{AUTO}$  in Figure 18 from 1M to 3.2M decreases the duty cycle to 0.8%.

## HOT SWAPPING TWO SUPPLIES

Using two external pass transistors, the LTC4211 can switch two supply voltages. In some cases, it is necessary to bring up the dominant supply first during power-up but ramp them down together during the power-down phase. The circuit in Figure 20 shows how to program two different delays for the pass transistors. The 5V supply is powered up first. R1 and C3 are used to set the rise and fall times on the 5V supply. Next, the 3.3V supply ramps

up with 20ms delay set by R6 and C2. On the falling edge, both supplies ramp down together because D1 and D2 bypass R1 and R6.

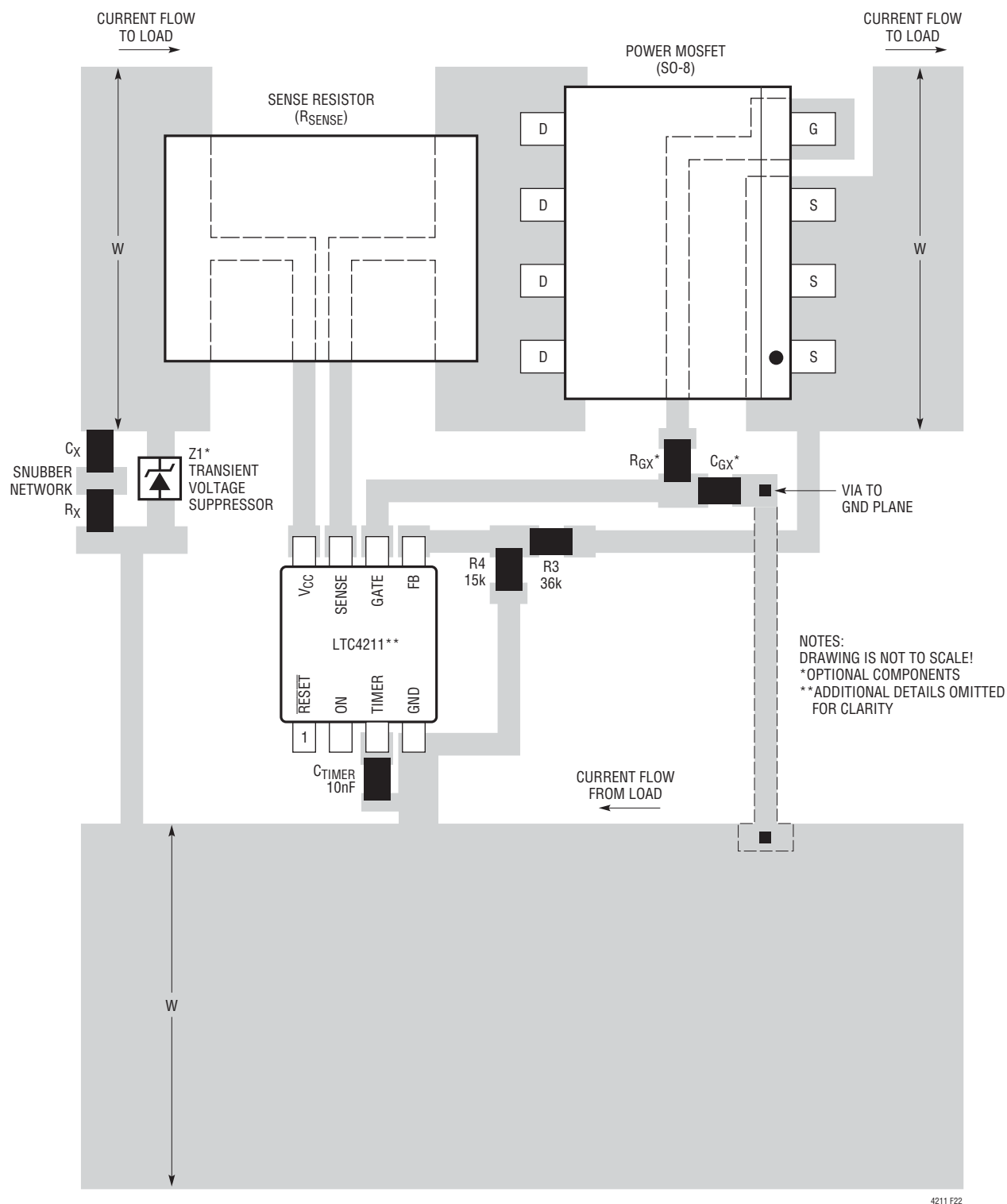
## OVERVOLTAGE TRANSIENT PROTECTION

Good engineering practice calls for bypassing the supply rail of any analog circuit. Bypass capacitors are often placed at the supply connection of every active device, in addition to one or more large value bulk bypass capacitors per supply rail. If power is connected abruptly, the large bypass capacitors slow the rate of rise of the supply voltage and heavily damp any parasitic resonance of lead or PC track inductance working against the supply bypass capacitors.

The opposite is true for LTC4211 Hot Swap circuits mounted on plug-in cards. In most cases, there is no supply bypass capacitor present on the powered supply voltage side of the MOSFET switch. An abrupt connection, produced by



## APPLICATIONS INFORMATION

Figure 22. Recommended Layout for LTC4211 Protection Devices, R<sub>SENSE</sub>, Power MOSFET and Feedback Network



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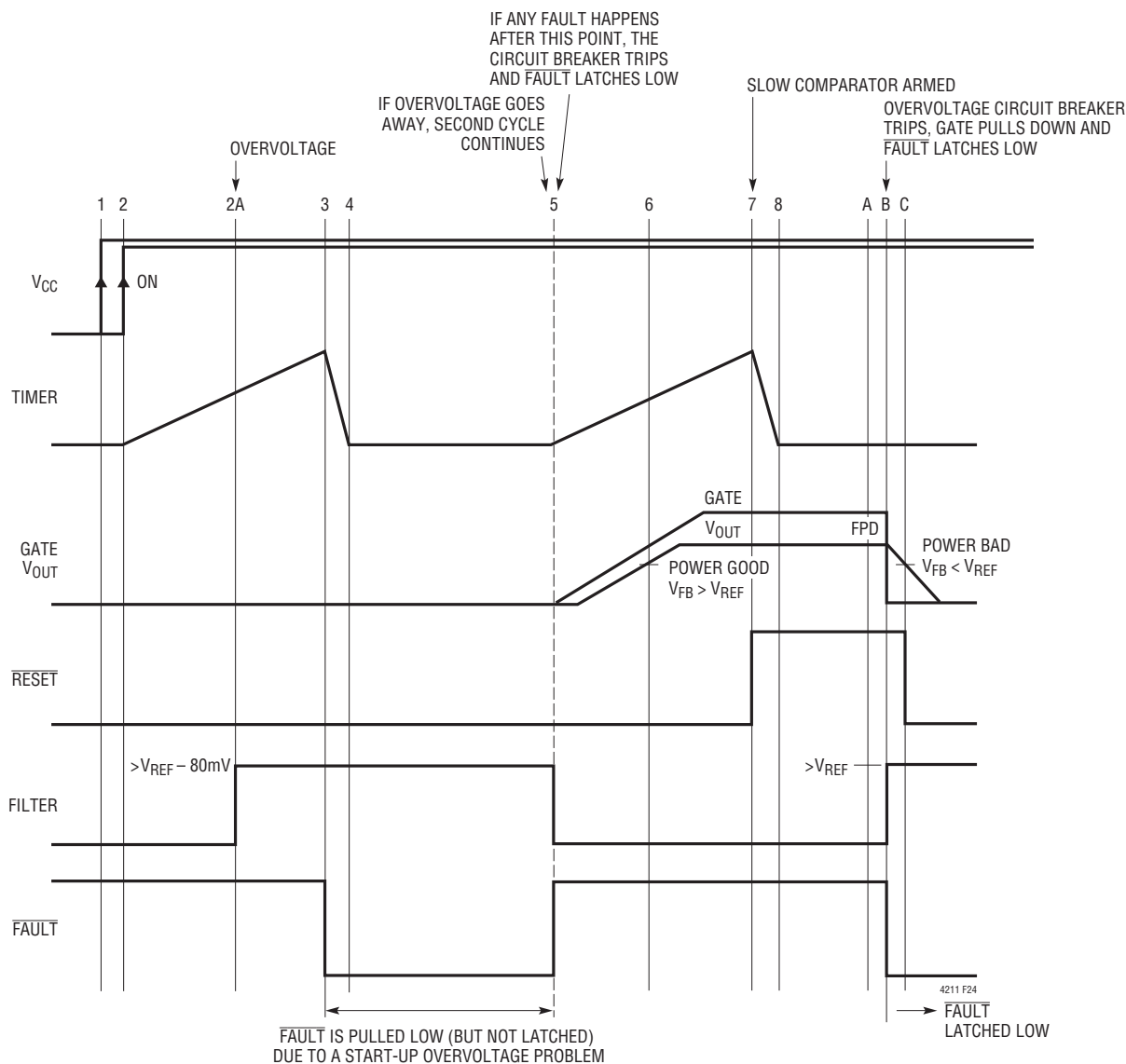


Figure 24. High Side Overvoltage Protection

## Low Side (Output) Overvoltage Protection

A Zener diode can be used in a similar fashion to detect/protect the system against a supply overvoltage condition on the load (or low) side of the pass transistor. In this case, the Zener diode is connected from the load to the LTC4211's FILTER pin, as shown in Figure 25. An additional diode, D1, prevents the FILTER pin from pulling low during an output short-circuit. Figure 26 illustrates the timing

diagram for a low side output overvoltage condition. In this example,  $V_{CC}$  starts up in an overvoltage condition but the LTC4211 can only sense the overvoltage supply condition at Time Point 6 when the GATE pin has ramped up. At Time Point 6,  $V_{FILTER}$  is greater than 1.236V, the circuit breaker is tripped, the GATE pin voltage is pulled to ground and  $\overline{FAULT}$  is asserted low and latched.

# APPLICATIONS INFORMATION

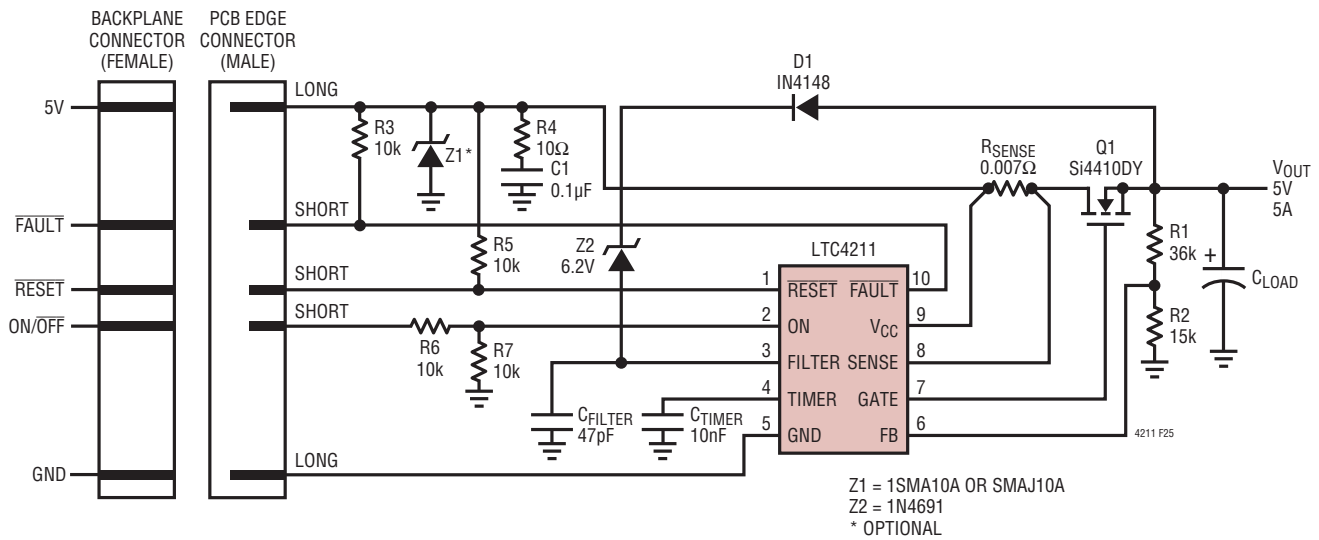


Figure 25. LTC4211MS Low Side Overvoltage Protection Implementation

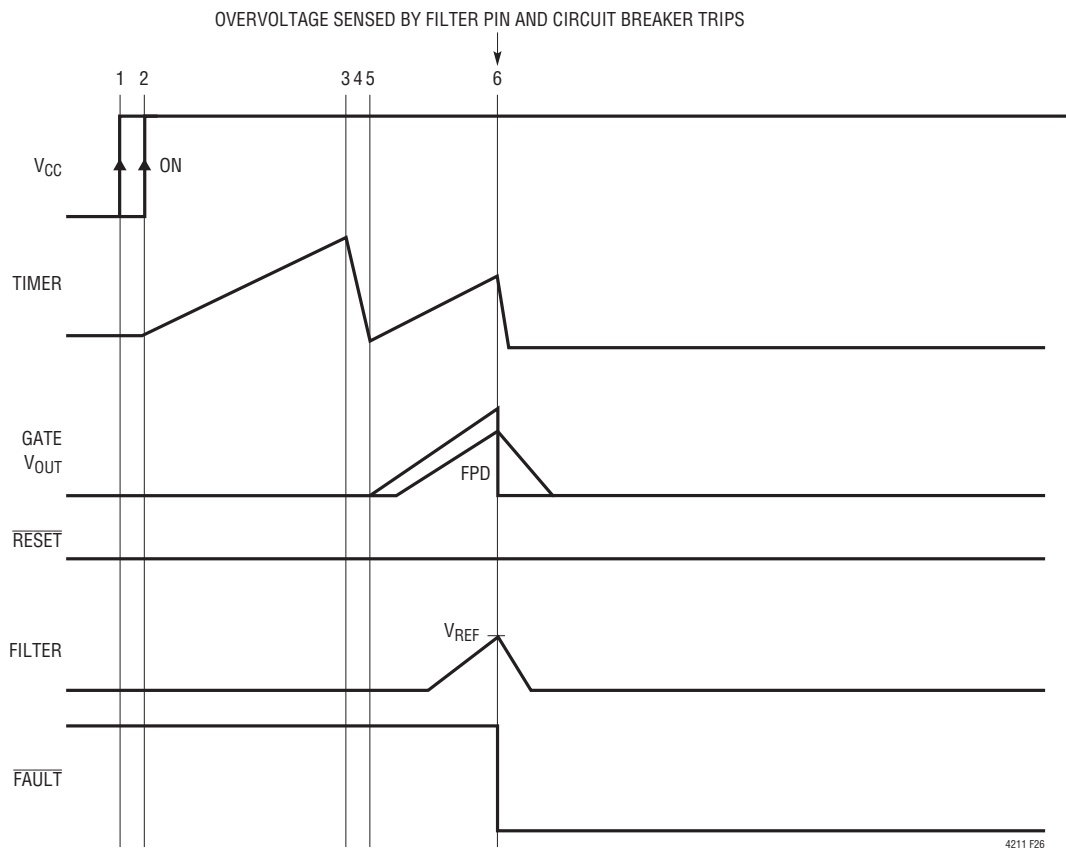


Figure 26. Low Side Overvoltage Protection

## APPLICATIONS INFORMATION

In either case, the LTC4211 can be configured to automatically initiate a start-up sequence. Please refer to the section on AutoRetry After a Fault for additional information.

### PCB Layout Considerations

For proper operation of the LTC4211's circuit breaker function, a 4-wire Kelvin connection to the sense resistors is highly recommended. A recommended PCB layout for the sense resistor, the power MOSFET and the GATE drive components around the LTC4211 is illustrated in Figure 22. In Hot Swap applications where load currents can reach 10A or more, narrow PCB tracks exhibit more resistance than wider tracks and operate at more elevated temperatures. Since the sheet resistance of 1 ounce cop-

per foil is approximately  $0.54\text{m}\Omega/\text{square}$ , track resistances add up quickly in high current applications. Thus, to keep PCB track resistance and temperature rise to a minimum, PCB track width must be appropriately sized. Consult Appendix A of LTC Application Note 69 for details on sizing and calculating trace resistances as a function of copper thickness.

In the majority of applications, it will be necessary to use plated-through vias to make circuit connections from component layers to power and ground layers internal to the PC board. For 1 ounce copper foil plating, a good starting point is 1A of DC current per via, making sure the via is properly dimensioned so that solder completely fills any void. For other plating thicknesses, check with your PCB fabrication facility.

## APPENDIX

Table 4 lists some current sense resistors that can be used with the circuit breaker. Table 5 lists some power MOSFETs that are available. Table 6 lists the web sites of several

manufacturers. Since this information is subject to change, please verify the part numbers with the manufacturer.

**Table 4. Sense Resistor Selection Guide**

| CURRENT LIMIT VALUE | PART NUMBER   | DESCRIPTION             | MANUFACTURER |
|---------------------|---------------|-------------------------|--------------|
| 1A                  | LR120601R050  | 0.05Ω 0.5W 1% Resistor  | IRC-TT       |
| 2A                  | LR120601R025  | 0.025Ω 0.5W 1% Resistor | IRC-TT       |
| 2.5A                | LR120601R020  | 0.02Ω 0.5W 1% Resistor  | IRC-TT       |
| 3.3A                | WSL2512R015F  | 0.015Ω 1W 1% Resistor   | Vishay-Dale  |
| 5A                  | LR251201R010F | 0.01Ω 1.5W 1% Resistor  | IRC-TT       |
| 10A                 | WSR2R005F     | 0.005Ω 2W 1% Resistor   | Vishay-Dale  |

**Table 5. N-Channel Selection Guide**

| CURRENT LEVEL (A) | PART NUMBER | DESCRIPTION                                                                 | MANUFACTURER     |
|-------------------|-------------|-----------------------------------------------------------------------------|------------------|
| 0 to 2            | MMDF3N02HD  | Dual N-Channel SO-8<br>$R_{DS(ON)} = 0.1\Omega$ , $C_{ISS} = 455pF$         | ON Semiconductor |
| 2 to 5            | MMSF5N02HD  | Single N-Channel SO-8<br>$R_{DS(ON)} = 0.025\Omega$ , $C_{ISS} = 1130pF$    | ON Semiconductor |
| 5 to 10           | MTB50N06V   | Single N-Channel DD Pak<br>$R_{DS(ON)} = 0.028\Omega$ , $C_{ISS} = 1570pF$  | ON Semiconductor |
| 10 to 20          | MTB75N05HD  | Single N-Channel DD Pak<br>$R_{DS(ON)} = 0.0095\Omega$ , $C_{ISS} = 2600pF$ | ON Semiconductor |

**Table 6. Manufacturers' Web Sites**

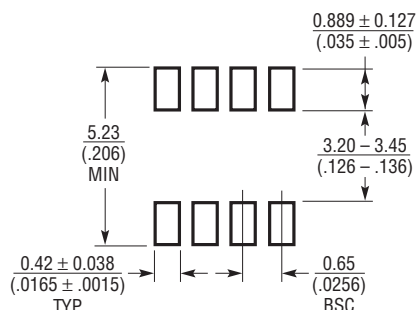
| MANUFACTURER            | WEB SITE                                                     |
|-------------------------|--------------------------------------------------------------|
| TEMIC Semiconductor     | <a href="http://www.temic.com">www.temic.com</a>             |
| International Rectifier | <a href="http://www.irf.com">www.irf.com</a>                 |
| ON Semiconductor        | <a href="http://www.onsemi.com">www.onsemi.com</a>           |
| Harris Semiconductor    | <a href="http://www.semi.harris.com">www.semi.harris.com</a> |
| IRC-TT                  | <a href="http://www.irc-tt.com">www.irc-tt.com</a>           |
| Vishay-Dale             | <a href="http://www.vishay.com">www.vishay.com</a>           |
| Vishay-Siliconix        | <a href="http://www.vishay.com">www.vishay.com</a>           |
| Diodes, Inc.            | <a href="http://www.diodes.com">www.diodes.com</a>           |

## PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

### MS8 Package 8-Lead Plastic MSOP

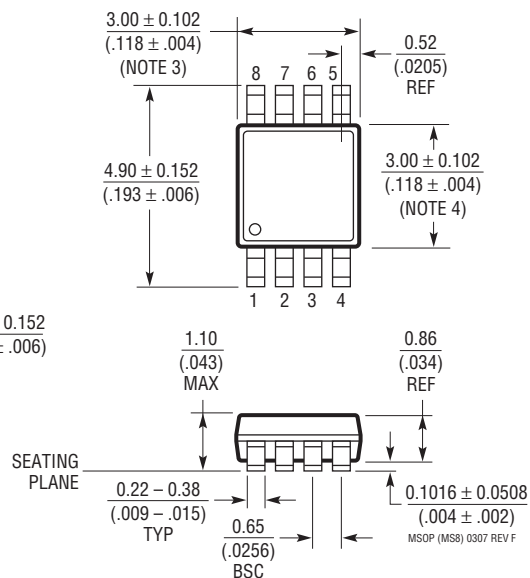
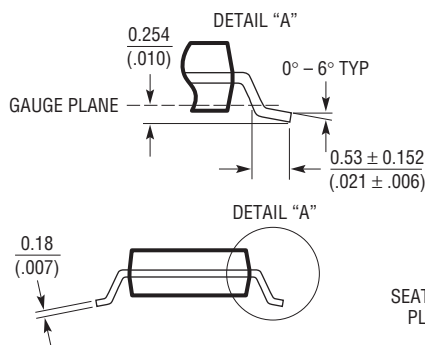
(Reference LTC DWG # 05-08-1660 Rev F)



RECOMMENDED SOLDER PAD LAYOUT

#### NOTE:

1. DIMENSIONS IN MILLIMETER/(INCH)
2. DRAWING NOT TO SCALE
3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.  
MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.  
INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX

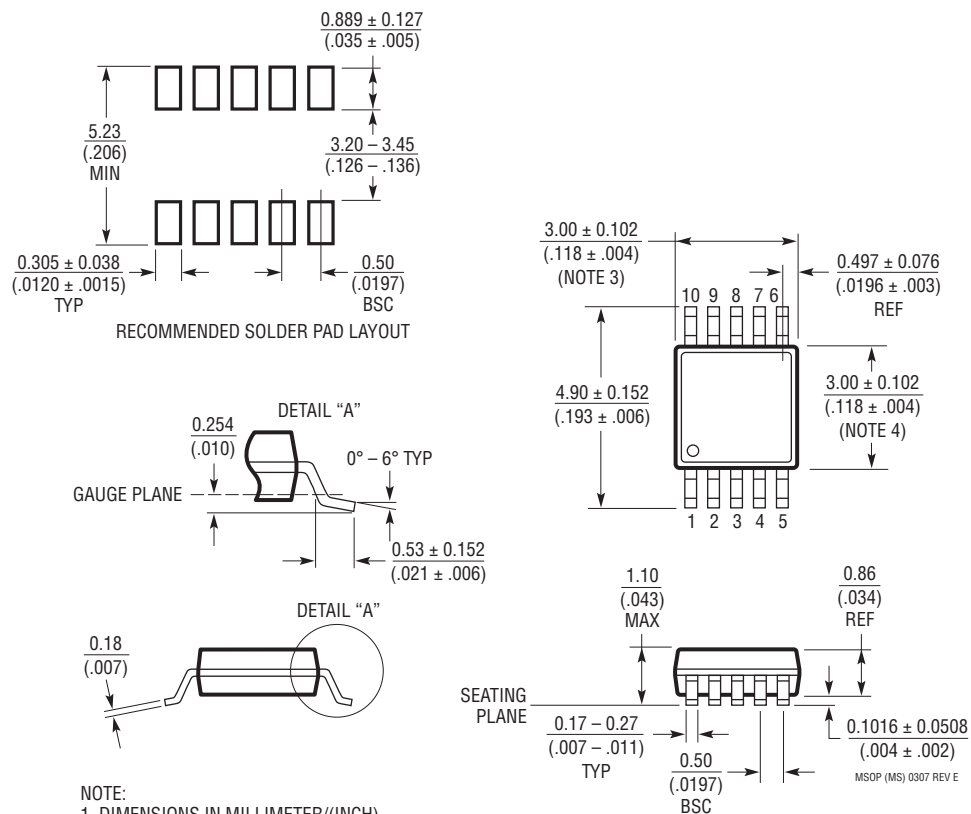


## PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

### MS Package 10-Lead Plastic MSOP

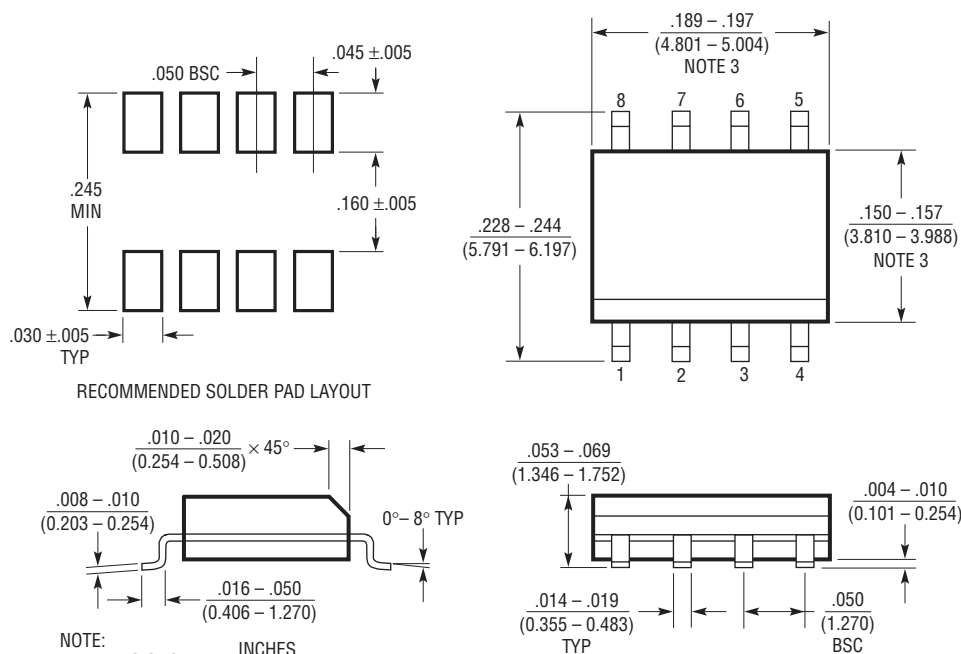
(Reference LTC DWG # 05-08-1661 Rev E)



## PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

### S8 Package 8-Lead Plastic Small Outline (Narrow .150 Inch) (Reference LTC DWG # 05-08-1610 Rev G)



- NOTE:
1. DIMENSIONS IN INCHES (MILLIMETERS)
  2. DRAWING NOT TO SCALE
  3. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006" (0.15mm)
  4. PIN 1 CAN BE BEVEL EDGE OR A DIMPLE

S08 REV G 0212

**REVISION HISTORY** (Revision history begins at Rev B)

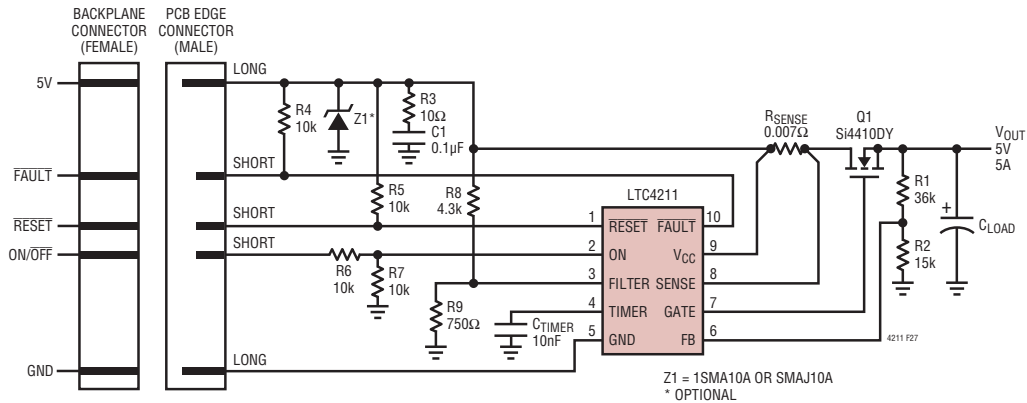
| REV | DATE  | DESCRIPTION                                                                    | PAGE NUMBER |
|-----|-------|--------------------------------------------------------------------------------|-------------|
| B   | 03/12 | Updated Pin description information                                            | 10, 11      |
|     |       | Updated Figure 2 and supporting text                                           | 13          |
|     |       | Moved Figure 7 and supporting text to page 16 and renumbered to Figure 6       | 16          |
|     |       | Updated text under Second Timing (Soft-Start) Cycle                            | 16          |
|     |       | Replaced $C_{GX}$ with $C_{GATE}$ in Figure 6                                  | 16          |
|     |       | Revised Figure 26 and supporting Low Side (Output) Overvoltage Protection text | 32, 33      |

## TYPICAL APPLICATION

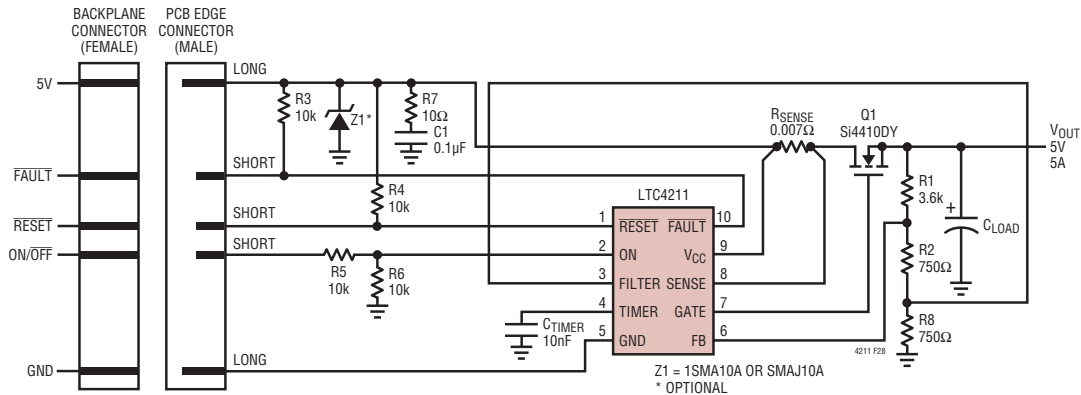
### LOW COST OVERVOLTAGE PROTECTION

There is an alternative method to implementing the overvoltage protection using a resistor divider at the FILTER pin (see Figures 27 and 28). In this implementation, the SLOW COMP is NULL in Normal Mode. Only the FAST

COMP circuit breaker is available and the current limit level is  $150\text{mV}/R_{\text{SENSE}}$ . During the soft-cycle, the inrush current servo loop is at  $50\text{mV}/R_{\text{SENSE}}$ . So, the heavy load should only turn on at/after the end of second cycle where the RESET pin goes high.



**Figure 27. LTC4211MS High Side Overvoltage Protection Implementation**  
(In Normal Mode, SLOW COMP Is Disabled. In Soft-Start Cycle,  $I_{\text{SOFTSTART}}$  Is Still  $50\text{mV}/R_{\text{SENSE}}$ )



**Figure 28. LTC4211MS Low Side Overvoltage Protection Implementation**  
(In Normal Mode, SLOW COMP Is Disabled. In Soft-Start Cycle,  $I_{\text{SOFTSTART}}$  Is Still  $50\text{mV}/R_{\text{SENSE}}$ )

## RELATED PARTS

| PART NUMBER       | DESCRIPTION                                                   | COMMENTS                                                              |
|-------------------|---------------------------------------------------------------|-----------------------------------------------------------------------|
| LTC1421           | Two Channels, Hot Swap Controller                             | 24-Pin, Operates from 3V to 12V and Supports -12V                     |
| LTC1422           | Single Channel, Hot Swap Controller                           | 8-Pin, Operates from 2.7V to 12V                                      |
| LT1640AL/LT1640AH | Negative Voltage Hot Swap Controller                          | 8-Pin, Operates from -10V to -80V                                     |
| LT1641-1/LT1641-2 | Positive Voltage Hot Swap Controller                          | 8-Pin, Operates from 9V to 80V, Latch-Off/Auto Retry                  |
| LTC1642           | Single Channel, Hot Swap Controller                           | 16-Pin, Overvoltage Protection to 33V                                 |
| LTC1644           | PCI Hot Swap Controller                                       | 16-Pin, 3.3V, 5V and $\pm 12\text{V}$ , 1V Precharge, PCI Reset Logic |
| LTC1647           | Dual Channel, Hot Swap Controller                             | 8-Pin, 16-Pin, Operates from 2.7V to 16.5V                            |
| LTC4230           | Triple Hot Swap Controller with Multifunction Current Control | Operates from 1.7V to 16.5V                                           |

4211fb



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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- Поставка более 17-ти миллионов наименований электронных компонентов;
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- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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